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MODIFIED THERMOPLASTIC NORBORNENE POLYMER AND PROCESS FOR THE (54) PRODUCTION THEREOF

A modified thermoplastic norbornene polymer obtained by graft-modifying a thermoplastic norbornene polymer selected from a ring-opening polymer of a norbornene monomer or a hydrogenated product thereof with at least one unsaturated compound selected from the group consisting of unsaturated epoxy compounds and unsaturated carboxylic compounds, and having a rate of graft modification of at least 10 mol% and a number average molecular weight (Mn) of 500 to 500,000, a production process thereof, and a crosslinking polymer composition comprising the modified thermobilastic norbornene polymer and a crosslinking agent.

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Description

(TECHNICAL FIELD)

[0001] The present invertion relates to modified thermoplastic nothornens polymers obtained by graft-modifying a ring-opening polymer of a norbornene monomer or a hydrogenated product thereof with an unsaturated epoxy compound or unsaturated carboxylic compound, and a production process thereof, and more particularly to modified thermoplastic norbornene polymers which are excellent in electrical properties such as delectric constant, adhesion property to other materials such as metals (metal tols, metallic wirings, etc.) and silicon wafers, hear tresistance, mois-ot ure resistance, etc., can be prepared into high-concentration solutions, and are also excellent in the ability to uniformly disperse various kinds of compounding additives in such a solution, and a production process thereof.

[0002] The modified thermoplastic norbornene polymers according to the present invention are suitable for use in electrical and electronic fields as impregnating resins for prepregs, sheets, interlayer insulating films and the like making good use of these excellent various properties

(BACKGROUND ART)

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(0003) With the rapid advancement of advanced information-oriented society in recent years, there is a strong demand for the speeding up of information processing and the miniaturization of apparatus or device in field of the electronic industry. In electronic parts used in electrical apparatus and electronic equipment, such as semiconductors, ICs, hybrid ICs, printed boards, display devices and display parts, insulating materials having a sufficiently low dielectric constant in a high-frequency region are required for purpose of realizing the speeding up and miniaturization in the high-frequency region. In order to ensure high reliability over a long period of time, insulating materials also excellent in heat resistance such as soldering heat resistance, and moisture resistance are also required. Further, the speeding up and information processing apparatus such as computers and communication exportants. In addition, their miniaturization and weight saving are required so as to be portation. Repending with such requirements, it is strongly required of circuits installed in these apparatus to make circuit boards high performance such as multi-layer structure, high precision and minute processing.

[0004] In recent years, there has been developed a multi-chip module (MCM) for flip chip packaging, by which miniaturized and high-density packaging has been realized. In order to ensure high reliability over a long period of time, an insulating material used in an interlayer insulating film for this MCM is required to have, in addition to the above required properties, sufficient adhesion property to substrates such as silicon waters, and conducting layers such as metal layers (metal foils, metallized films, etc.), since MCM is tabricated by laying many insulating layers and conductive layers on one another on a substrate such as a silicon water. In addition, since to be able to make a via diameter small by reduction in wiring pitch is require of MCM, it is required to impart photosensitivity to the insulating material in order to make minute processing possible.

[0005] As insulating materials for MCM, there have heretofore been investigated materials obtained by imparting photosensitivity to a polyimide resin or epoxy resin. However, the conventional photosensitive polyimide resins are insufficient in electrical properties such as dielectric constant in a high-frequency region and also in moisture resistance and hence have involved a drawback that it is difficult to cope with the achievement of high reliability over a long period of time. In the epoxy resins, it has been attempted to introduce a photosensitive group such as an ally group impart photosensitivity to the resins. However, such an attempt has involved a drawback that electrical properties, such as dielectric constant, of the resultant resins are deteriorated to a great extent, and their heat stability also become

Fig. 2006] On the other hand, a circuit board is produced by impregnating a reinforcing base material, for example, a glass cloth, with a resin varnish, drying the varnish to form a sheet (prepreg) in a semi-cured state, laying up a copper toil or outer copper-clad sheet, the prepreg, an inner copper-clad sheet, and the like in that order between mirror plates and then hot-pressing the resultant laminate to completely cure the resin. As a resin material, there has heretofore been used a otherol resin, estory resin, polyindre resin, fluororesin, polybutadien eresin or the like.

50 [0007] However, the dielectric constant of thermosetting resins such as the phenol resin, epoxy resin and polyimide resin is generally as high as at least 4.0, and so their electrical properties are insufficient. Therefore, circuit boards making use of these thermosetting resins have been difficult to achieve the speeding up and high reliability of arithmetic processing. On the other hand, circuit boards making use of thermoplastic resins such as the fluororesins and polybusticine resins are poor in heat resistance and so may cause cracking and/or delamination in some cases upon soldering or the like. In addition, such resins have also been difficult to form a multi-layer structure due to their poor

dimensional stability.
[0008] Accordingly, in recent years, it has been proposed to use thermoplastic norbornane resins as insulating mate-

[0009] For example, Japanese Patent Application Laid-Open No. 34924/1987 discloses a process comprising synthesizing a norbornene resin having an intrinsic viscosity [n] of 1.15 to 2.22 as measured at 135°C in decalin by addition polymerization of a norbornene type cyclooletin and ethylene, kneading the norbornene resin and a crosslinking aid, grinding the resultant mixture, impregnating the ground mixture with a solution of an organic peroxide, removing the solution and then press molding it to crosslink the resin.

[0010] However, this process has involved problems that the process is complicated, and besides it is difficult to prepare a high-concentration solution of the norbornear eain, and the organic peroxide and other compounding additives are not uniformly dispersed. Accordingly, it is necessary to prepare a low-concentration solution in order to produce a prepreg using a solution of the resin obtained by this process. When the reinforcing base material is impregnated with the low-concentration solution, however, it takes a long time to dry the solution until it becomes tackfeet at room temperature, and so the base material must be left at rest so as not to deform in the meantime. Therefore, this process involves a problem of poor productivity. In addition, various kinds of compounding additives must be left and the compounding additives to various uses. However, such compounding additives cannot be uniformly dispersed in the resin solution due to the high viscosity of the solution, and there is also an disadvantage that the resin solution and the compounding additives used. If the reinforcing base material is impregnated with the solution phase-separated into 2 phases, any prepreg in which the individual components are uniformly dispersed cannot be obtained. In addition, if a copper foil is laminated on the thus-obtained molding such as the prepreg, the resultant laminate has no sufficient peel strength and hence involves a problem of durability.

[0011] Japanese Patent Application Laid-Open No. 248164/1994 discloses a process in which a hydrogenated thermoplastic ring-opening norbornene resin, an organic peroxide, a crosslinking aid and a flame relardant such as brominated bisphenol are dispersed in a solvent, and casting is conducted using the resultant solution, or a reinforcing base
material is impregnated with the solution, and the solvent is then removed to crosslinking the resin by heating, thereby
producing a sheet, prepreg or the like. When the norbornene resin specifically disclosed in this publication is used, however, it is difficult to make a solids concentration sufficiently high, and so productivity in a drying step comes insufficient. In addition, such a process has involved a problem that such a sheet or prepreg cannot be fully applied according
to use fields, since the kinds and amounts of compounding additives which can be uniformly dispersed are limited, and
moreover its peel strength to a copper film is insufficient.

[0012] Japanese Patent Application Laid-Open No. 27412/1987 has proposed modified cycloolefin copolymers obtained by grafting an unsaturated epoxy compound such as allyl glycidyl ether on an addition copolymer of ethylene and a norbornene monomer. Japanese Patent Application Laid-Open No. 20692/1996 has proposed resin compositions comprising a cycloolefin resin having a carboxylic acid derivative type residue and a heat-crosslinking agent and/or a photo-crosslinking agent. Japanese Patent Application Laid-Open No. 259784/1996 has proposed resin compositions comprising an epoxy group-containing cycloolefin resin and a crosslinking agent. All of these resin materials have been reported to be excellent in electrical properties, heat resistance, adhesion property, etc.

have been reported to be exceeded in fleetune properties, many todams of these prior and documents are all insufficient in the rate of graft modification. Therefore, they are insufficient in adhesion property to other materials such as metals and silicon waters and moreover in heat resistance, and thus have involved a problem that deformation and cracking tend to occur in a solder reflowing step or a sputtering step.

(DISCLOSURE OF THE INVENTION)

[0014] It is an object of the present invention to provide modified thermoplastic norbornene polymers which are excellent in electrical properties such as dielectric constant in a high-frequency region, heat resistance, moisture resistance and heat stability and also in adhesion property to other materials such as metals and silicon waters, and a production process thereof.

[0015] Another object of the present invention is to provide crosslinking polymer compositions comprising an epoxy group-containing norbornene polymer which is excellent in electrical properties such as dielectric constant in a high-frequency region, heat resistance, moisture resistance and heat stability and also in adhesion property to other materials such as metals and silicon waters, and is also suitable for compounding of a crosslinking agent.

[0016] A further object of the present invention is to provide modified thermoplastic norborners polymers which are excellent in heat resistance, electrical properties such as dielectric constant, and peel strength to metal folls, can be prepared into high-concentration solutions, and are also excellent in the ability to uniformly disperse various kinds of compounding additives in such a solution, a production process thereof, and crosslinking polymer compositions comprising such a modified thermoplastic norborners polymer and a crosslinking agent.

[0017] The present inventor has carried out an extensive investigation with a view toward overcoming the abovedescribed problems involved in the prior art. As a result, it has been found that the above objects can be achieved by graft-modifying a iring-opening polymer of a norbornene monomer, which has a molecular weight within a specific

range, or a hydrogenated product thereof with at least one unsaturated compound selected from the group consisting of unsaturated epoxy compounds and unsaturated carboxylic compounds.

[0018] Of the modified thermoplastic norbornene polymers according to the present invention, comparatively lowmolecular weight polymers having a rate of graft modification of at least 10 motifs and a number average molecular
weight (Mn) of 500 to 20,000 can be prepared into high-concentration solutions, and various compounding additives
can be uniformly dispersed at a high concentration in such a solution. Since such a solution is excellent in the ability to
impregnate reinforcing base materials and also good in film-forming property, prepress and sheets can be produced by
using a crosslinking polymer composition comprising the modified thermoplastic norbornene polymer and a crosslinking agent. In addition, laminates produced from the prepregs or sheets are excellent in heat resistance and dielectric
constant, and moreover a laminate excellent in peel strength to a metal layer can be provided when the metal layer is
laminated on such a prepreg or sheet.

[0019] Of the modified thermoplastic norbonnene polymers according to the present invention, comparatively highmolecular weight polymers having a rate of graft modification of at least 10 mol% and a number average molecular
weight (Mn) exceeding 20,000 are excellent in electrical properties such as dielectric constant in a high-frequency
region, heat resistance, moisture resistance and heat stability, and also in adhesion property to other materials such as
metals and silicon wafers. Therefore, such polymers are particularly suitable for use as overcoats, interlayer insulating
films and the like.

[0020] In addition, various crosslinking methods such as crosslinking by heat and crosslinking by light can be applied to the modified thermoplastic norbornene polymers according to the present invention by selecting the kind of a crosslinking agent used.

[0021] The present invention has been led to completion on the basis of these findings.

[0022] According to the present invention, there is thus provided a modified thermoplastic notionness polymer obtained by graft-modifying a thermoplastic norbornene polymer selected from a ring-opening polymer of a norbornene monomer or a hydrogenated product thereof with at least one unsaturated compound selected from the group consisting of unsaturated epoxy compounds and unsaturated carboxylic compounds, wherein the modified polymer has a rate of graft modification of all least 10 mol% and a number average molecular weight (Mn) o 500 to 500.00.

[0023] According to the present invention, there is also provided a process for producing a modified thermoplastic nothornene polymer having a rate of graft modification of at least 10 mot% and a number average molecular weight (Mn) of 500 to 500,000, the process comprising reacting a thermoplastic nothornene polymer selected from a ring-opening polymer of a nothornene monomer or a hydrogenated product thereol and having a number average molecular weight (Mn) of 500 to 500,000 with at least one unsaturated compounds elected from the group consisting of unsaturated egory compounds and unsaturated carboxylic compounds in the presence of an organic peroxide.

[0024] According to the present invention, there is further provided a crosslinking polymer composition comprising a modified thermoplastic norbornene polymer obtained by graft-modifying a thermoplastic norbornene polymer selected from a ring-opening polymer of a norbornene monomer or a hydrogenated product thereof with at least one unsaturated compound selected from the group consisting of unsaturated epoxy compounds and unsaturated carboxylic compounds, and having a rate of graft modification of at least 10 mol% and a number average molecular weight (Mn) of 500 to 500,000, and a crosslinking agent.

(BEST MODE FOR CARRYING OUT THE INVENTION)

Modified thermoplastic norbornene polymer:

[0025] The modified thermoplastic norbornene polymers useful in the practice of the present invention are those betained by graft-modifying a thermoplastic norbornene polymer having a number average molecular weight (Mn) of 500 to 500,000 with at least one unsaturated compound selected from the group consisting of unsaturated epoxy compounds and unsaturated carboxylic compounds.

[0026] As the thermoplastic norbornene polymer, is used a ring-opening polymer of a norbornene monomer or a hydrogenated product thereof. The hydrogenated product of the ring-opening polymer of the norbornene monomer is particularly preferred from the viewpoints of heat resistance, durability and electrical properties such as dielectric constant.

(1) Norbornene monomer:

55 [0027] No particular limitation is imposed on the norbornene monomer, ring-opening polymer of the norbornene monomer, and hydrogenated product thereof used in the present invention. Publicly known monomers and polymers disclosed in, for example, Japanese Patent Application Laid-Open Nos. 14882/1991 and 122137/1991, etc. may be used. [0028] The norbornene monomers are publicly known compounds disclosed in the above-described publications and

Japanese Patent Application Laid-Open Nos. 227424/1990 and 276842/1990, etc. Examples thereof include polycyclic hydrocarbons having a norbornene structure; alkyl-, alkenyl-, alkylidene- or aromatic-substituted derivatives thereof; their derivatives substituted by a polar group such as a halogen, hydroxyl group, ester group, alkoxy group, cyano group, amide group, mide group or silyl group; alkyl-, alkenyl, alkylidene- or aromatic-substituted derivatives of the norbornene monomers having such a polar group; etc. Of these, the polycyclic hydrocarbons having a norbornene structure, and abxyl-, alkenyl, alkylidene- or aromatic-substituted derivatives thereof are preferred in that they are particularly excellent in chemical resistance and moisture resistance.

[0029] The typical noncornene monomers used in the present invention are compounds represented by the formula (a):

wherein R¹ to R⁸ are independently a hydrogen atom, hydrocarbon group, halogen atom, alkoxy group, ester group, cyano group, amide group, limide group, silyl group or hydrocarbon group substituted by a polar group (i.e., a halogen atom, alkoxy group, ester group, cyano group, amide group, initide group or silyl group), with the proviso that at least two of R⁵ to R⁸ may be bonded to each other to form a monocycle or polycycle, the monocycle or polycycle may have carbon-carbon double bond(s) or be in the form of an aromatic ring, and R⁵ and R⁶, or R⁷ and R⁸ may form an allyfidene group.

[0030] Examples of the halogen atom in the formula (a) include fluorine, chlorine, bromine and lodine atoms. Examples of the hydrocarbon group include alklyl groups having 1 to 20 carbon atoms, preferably 1 to 10 carbon atoms, preferably 2 to 20 carbon atoms, preferably 3 to 10 carbon atoms, preferably 3 to 18 carbon atoms, preferably 3 to 18 carbon atoms, and anyl groups having 6 to 12 carbon atoms, preferably 6 to 8 carbon atoms. Examples of the hydrocarbon group substituted by a polar group include halogenated alkly groups having 1 to 20 carbon atoms. Preferably 1 to 10 carbon atoms, preferably not substituted by any polar group include halogenated alkly groups having 1 to 20 carbon atoms. The alkylidene group is preferably not substituted by any polar group, since the moisture resistance of the resulting polymer is highly enhanced. The number of carbon atoms thereof is generally within a range of 1 to 20, preferably 1 to 10.

[0031] Specific examples of the alkyl groups include methyl, ethyl, n-propyl, isopropyl, n-butyl, n-amyl, n-heayl and decyl groups. Specific examples of the alkeryl groups include viryl, propenyl, butenyl, pentenyl and haxenyl groups. Specific examples of the aromatic groups include phenyl, tolyl, xylyl, biphenyl and napithyl groups. Specific examples of the alkylidene group include methylidene, ethylidene, propylidene and isopropylidene groups. Examples of the ester group include alkyl ester groups.

[0032] In the formula (a), each of R¹ to R⁴ is preferably a hydrogen atom or hydrocarbon group when high moisture resistance is required. At least two of R⁵ to R⁸ may be bonded to each other to form a monocyde or polycycle, and the monocyde or polycycle may have carbon-carbon double bond(s) or be in the form of an aromatic ring. In this case, the monocyde or polycycle may have such a substituent group (hydrocarbon group, polar group or hydrocarbon group substituted by the polar group) as described above. In this case, however, the monocycle or polycycle preferably has no polar group when high moisture resistance is required.

[0033] As preferable examples of the norbornene monomers represented by the formula (a), may be mentioned compounds represented by the formula (a1):

$$R^{\mu}$$
 R^{μ}
 R^{μ}

[0034] In the formula (a1), R9 to R20 are independently a hydrogen atom, hydrocarbon group, halogen atom, alkoxy group, ester group (for example, alkyl ester group), cyano group, amide group, imide group, silyl group or hydrocarbon group substituted by a polar group (i.e., a halogen atom, alkoxy group, ester group, cyano group, amide group, imide group or silyl group). When high moisture resistance is required of the resulting polymer, each of these groups is a hydrogen atom or hydrocarbon group. However, at least two of R 17 to R 20 may be bonded to each other to form a monocycle or polycycle, and the monocycle or polycycle may have carbon-carbon double bond(s) or be in the form of an aromatic ring, R¹⁷ and R¹⁸, or R¹⁹ and R²⁰ may form an alkylidene group. It goes without saying that the monocycle, polycycle or aromatic ring may have such a substituent group (hydrocarbon group, polar group or hydrocarbon group substituted by the polar group) as described above. In this case, however, such a cycle or ring preferably has no polar group when high moisture resistance is required. Specific examples of these substituents are the same as described

[0035] As other preferable examples of the norbornene monomers represented by the formula (a), may be mentioned compounds represented by the formula (a2):

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[0036] In the formula (a2), m is 0, 1 or 2. When m is 0, a cyclopentane ring is formed. R21 to R32 are independently a hydrogen atom, hydrocarbon group, halogen atom, alkoxy group, ester group (for example, alkyl ester group), cyano group, amide group, imide group, silyl group or hydrocarbon group substituted by a polar group (i.e., a halogen atom, alkoxy group, ester group, cyano group, amide group, imide group or silyl group). When high moisture resistance is required of the resulting polymer, each of these groups is a hydrogen atom or hydrocarbon group. However, at least two of R²⁹ to R³² may be bonded to each other to form a monocycle or polycycle, and the monocycle or polycycle may have carbon-carbon double bond(s) or be in the form of an aromatic ring. R²⁹ and R³⁰, or R³¹ and R³² may form an alkylidene group, or R30 and R31 may be bonded to each other to form a double bond between 2 carbon atoms to which R30 and R31 are bonded, respectively. It goes without saying that the monocycle, polycycle or aromatic ring may have such a substituent group (hydrocarbon group, polar group or hydrocarbon group substituted by the polar group) as described above. In this case, however, such a cycle or ring preferably has no polar group when high moisture resistance is required. Specific examples of these substituents are the same as described above.

Specific examples of the norbornene monomers include blcyclo[2.2.1]hept-2-ene derivatives, tetracvolo-14.40.12.5¹/19.3-dodecene derivatives, octacy-clo[8.8.0,12.9,14.7,11.18,113.16,03.8,012.17.5-6 docesene derivatives, octacy-clo[8.8.0,12.9,14.7,11.18,113.16,03.8,012.17.5-6 docesene derivatives, pentacyclo[6.6.1.13.6,02.7,93.14]-4-hexadecene derivatives, heptacyclo-5-eicosene derivatives, heptacyclo-5-heneicosene derivatives, tricyclo[4.3.0.1^{2,5}]-3-decene derivatives, tricytol(4.0.1.2⁵)-3-undecene derivatives, pentacytol(5.1.1.3⁶,0.7.0^{5,13})-4-pentadecene derivatives, pentacytol(5.1.1.3⁶,0.7.0^{5,13})-4-pentadecene derivatives, pentacytol(5.1.1.3⁶,0.7.0^{5,13})-4-pentadecene derivatives, pentacytol(7.4.0.1.2⁵,1.9.12,0.8.13)-3-pentadecene derivatives, pentacytol(7.4.0.1.2⁵,1.9.12,0.8.13)-3-pentadecene derivatives, pentacytol(7.4.0.1.2⁵,1.9.12,0.8.13)-3-pentadecene derivatives, pentacytol(8.0.1.13,10.1.13, clo[10,10,1,1^{5,8},1^{14,21},1^{16,19},0^{2,11},0^{4,9},0^{13,22},0^{15,20}]-5-hexacosene derivatives. 1.4-methano-1.4.4a.9atetrahydrofluorone derivatives, 1,4-methano-1,4,4a,5,10,10a-hexahydro-anthracene derivatives and cyclopentadiene-

acenaphthylene adducts. [0038] More specifically, examples of the norbornone monomors include bicyclo[2.2.1]hept-2-ene derivatives such as bicyclo[2.2.1]hept-2-ene, 6-methylbicyclo[2.2.1]hept-2-ene, 5,6-dimothylbicyclo[2.2.1]hept-2-ene, 1-methylbicydo[2.2.1]hept-2-one, 6-ethylbicyclo[2.2.1]hept-2-ene, 6-n-butylbicyclo[2.2.1]hept-2-ene, 6-isobutylbicyclo[2.2.1]hept-2-ene and 7-methylbicyclo[2.2.1]hept-2-ene; tetracyclo[4.4.0.12.5.17.10]-3-dodecene derivatives such as tetracy-

butyltetracyclo[4.4.0.1^{2,5}.1^{7,10}]-3-dodecene, 8-hexyltetracyclo[4.4.0.1^{2,5}.1^{7,10}]-3-dodecene, 8-cyclohexyltetracy-

8-stearyltetracyclo[4.4.0.12,5.17,10]-3-dodecene. clo[4 4 0 12,5 17,10]-3-dodecene. dimethyltetracyclo[4.4.0.1^{2.5},1^{7,10}]-3-dodecene, 2,10-dimethyltetracyclo[4.4.0.1^{2.5},1^{7,10}]-3-dodecene, 8,9-dimethyltetracyclo[4.4.0.1^{2.5},1^{7,10}]-3-dodecene, 8,9-dimethyltetracyclo[4.4.0.1^{2.5}]-3-dodecene, 8,9-dimethyltetracyclo[4.4.0.1^{2.5}]-3-dodecene, 8,9-dimethylt racyclo[4.4.0.1^{2,5}.1^{7,10}]-3-dodecene, 8-ethyl-9-methyltetracyclo[4.4.0.1^{2,5}.1^{7,10}]-3-dodecene. 11.12-dimethyltetracy-1^{2,5}, 1^{7,10}]-3-dodecene. clol4 4 0 12,5 17,101-3-dodecene 2.7.9-trimethyltetracyclo-[4.4.0. 9-ethyl-2.7dimothyltetracyclo[4,4,0,1^{2,5},1^{7,10}]-3-dodecene 9-isobutyl-2,7-dimethyltetracyclo[4.4.0.12,5,17,10]-3-dodecene. 9,11,12-trimothyltetracyclo[4.4.0.1^{2,5}.1^{7,10}]-3-dodecene, 9-ethyl-11, 12-dimethyltetracyclo[4,4,0,12,5,17,10]-3-9-isobutyl-11, 12-dimethyltetracyclo[4.4.0.1^{2,5}, 1^{7,10}]-3-dodecene, 5,8,9,10-tetramethyltetracyclof4.4.0.1^{2,5}.1^{7,10}]-3-dodecene, 8-ethylidene-9-methyltetracyclo[4.4.0.1^{2,5}.1^{7,10}]-3-dodecene, 8-ethylidene-9-ethyltetracyclo racyclol4.4.0.12.5.17.101-3-dodecene. 8-ethylidene-9-isopropyltetracyclol4.4.0.12.5.17.101-3-dodecene. 8-ethylidene-9-isopropyltetracyclol4.4.0.12.5.17.101-3-dodecene. 8-ethylidene-9-isopropyltetracyclol4.4.0.12.5.17.101-3-dodecene. racycoj 4,4.0.1²⁻³,11°9-3-odocene, 6-enylioene-9-isopropyteracycoj 4,4.0.1²⁻³,11°9-3-odocene, 8-enypioene-butyltetracycloj 4,4.0.1²⁻⁵,11°9-3-odocene, 8-propytidene-9-entyltetracycloj 4,0.1²⁻⁵,11°9-3-odocene, 8-propytidene-9-butyltetracycloj 4,0.1²⁻⁵,11°9-3-odocene, 8-propytidene-9-butyltetracycl [4.4.0.1^{2.5}.1^{7,10}]-3-dodecene, 8-isopropylidene-9-ethyl-tetracyclo[4.4.0.1^{2.5}.1^{7,10}]-3-dodecene. 8-isopropylidene-9-isopropyttetracyclo[4.4.0.12.5.17.10]-3-dodecene, 8-isopropylidene-9-butyltetracyclo[4.4.0.12.5.17.10]-3-dodecene, 8-chlorototracyclo[4.4.0.1^{2,5}.1^{7,10}]-3-dodecene, fluorotetracyclo[4.4.0.1^{2,5}.1^{7,10}]-3-dodecene 8-bromotetracyclo[4.4.0.1^{2,5}.1^{7,10}]-3-dodecene, 8.9-dichlorotetracyclo[4.4.0.12.5.17,10]-3-dodecene: nuoroterracycio (4.0.1) ***-11***|-3-dodecene an 8,9-dicnioroterracycio (5.1.13⁶, 10.13.0²7, 0³.14] -4-heptadecene, (616.6.1.13⁶, 10.13.0²7, 0³.14] -4-heptadecene, 12-methylhexacycio (6.6.1.13⁶, 10.13.0²7, 0³.14] -4-heptadecene, octacycio (6.6.1.13⁶, 10.13.0²7, 0³14] -4-heptadecene, octacycio (6.6.1.13⁶, 10.13.0 octacydo[8.8.0.1^{2.9},1^{4.7},1^{11,18},1^{13,16},0^{3,8},0^{12,17}]-5-docosene. 15-methyloctacyclo[8.8.0.12,9,14,7,111,18,113,16,03,8 0^{12,17}]-5-docosene 15-ethyloctacyclo[8.8.0.1^{2,9}.1^{4,7}.1^{11,18}. 1^{13,16}.0^{3,8}.0^{12,17}1-5-docosene; clo[6.5.1.1^{3,6}.0^{2,7}0^{9,14}]-4-hexadocene derivatives such as pentacyclo[6.6.1.1^{3,6}.0^{2,7}0^{9,14}]-4-hexadocene, 1,3-dimethylpentacyclo[6.6.1.1^{3,6}.0^{2,7}0^{9,14}]-4-hexadecene, 1.6-dimethyloentacyclo[6.6.1.1^{3,6}.0^{2,7}0^{9,14}]-4-hexadecene and 15.16dimethylpentacyclo[6.6.1.1^{3,6}.0^{2,7}0^{9,14}]-4-hexadecene; heptacyclo-5-eicosene derivatives or heptacyclo-5-heneicosene derivatives such as heptacyclo[8.7.0.1^{2,9}.1^{4,7}.1^{11,17}.0^{3,8}. 0^{12,16}]-5-eicosene and heptacydol(8.8.0.12.5) 147.11.11.93.8, 012.17.5.heneicosene; tricyclo[4.3.0.12.5]-3-decene derivatives such as tricyclo[4.3.0.12.5]-3-decene, 2-methyltricyclo[4.3.0.12.5]-3-decene and 5-methyltricyclo[4.3.0.12.5]-3-decene; tricyclo[4.3.0.1^{2,5}]-3-undecene derivatives such as tricyclo[4.3.0.1^{2,5}]-3-undecene and 10-methytricyclo[4.3.0.1^{2,5}]-3undecene; pentacyclo[6.5.1.1^{3,6}.0^{2,7}.0^{9,13}]-4-pentadecene derivatives such as pentacyclo[6.5.1.1^{3,6}.0^{2,7}.0^{9,13}]-4-pentacene. 1.3-dimethylpentaycyclo[6.5.1.1^{3,6}.0^{2,7}.0^{9,13}]-4-pentacene, 1,6-dimethylpentacyclol[6.5.1.1^{3,6}.0^{2,7}.0^{9,13}]-4-clo[8, 7, 0, 1^{3,6}, 1^{10,17}, 1^{12,15}, 0^{2,7}, 0^{11,16}]-4-eicosene dimethyl-substituted clo[8.4.0.1^{2,5}.1^{9,12}.0^{8,13}]-3-hexadecene derivatives such as pentacyclo[8.4.0.1^{2,5}.1^{9,12}.0^{8,13}]-3-hexadecene, 11methylpentacyclo[8.4.0.1^{2,5},1^{9,12},0^{8,13}]-3-hexadecene, 11-ethylpentacyclo[8.4,0.1^{2,5},1^{9,12},0^{8,13}]-3-hexadecene and henéicosene; nonacyclo[10.10.1,1⁻⁻0.1⁻⁻1.1⁻0.2⁻1.1⁻0.9⁻1.0⁻0.9⁻0.1⁻0.9⁻1.0⁻1.0⁻0.1⁻0.9⁻1.0⁻0.1⁻1.0⁻0.1⁻1.0⁻0.1⁻1.1⁻0.0⁻1.0⁻0.1⁻1.1⁻0.0⁻1.0⁻0.1⁻1.1⁻0.0⁻1.0⁻0.1⁻1.1⁻0.0⁻1.0⁻0.1⁻1.1⁻0.0⁻1.0⁻1.0⁻1.1⁻0.0⁻0.1⁻0.1⁻1.1⁻0.0⁻1.0⁻1.0⁻1.0⁻1.0⁻0.0⁻1.0⁻ clo[7.8.0.1^{3,6}.0^{2,7}.1^{10,17}.0^{11,16}.1^{12,15}]-4-eicosene, tricyclo[4.3.0.1^{2,5}]-3,7-decadiene (i.e., dicyclopentadiene), 2,3dihydrodicyclopentadiene, 5-phenyl-bicyclo[2.2.1]hept-2-ene (i.e., 5-phenyl-2-norbornene), 5-methyl-5-phenylbicyclo[2,2,1]hept-2-ene, 5-benzyl-bicyclo[2,2,1]hept-2-ene, 5-tolylbicyclo[2,2,1]hept-2-ene, 5-(ethylphenyl)-bicycol(2.2.1)hept-2-ene, 5-(sopropy)pheny)-bicycl(2.2.1)hept-2-ene, 8-phenyf-tetracyclo(4.4.0.1^{2.5},1^{7.10})-3-dodecene, 8-berzyl-tetracyclo(4.4.0.1^{2.5},1^{7.10})-3-dodecene, 8-botyl-tetracyclo(4.4.0.1^{2.5},1^{7.10})-3-dodecene, 8-botyl-tetracyclo

tetracyclo[4.4.0.1^{2.5},1^{7,10}]-3-dodecene, 8-(β-naphthyl)-tetracyclo[4.4.0.1^{2.5},1^{7,10}]-3-dodecene. 8-(α-naphthyl)-tetracyclo[4.4.0.1^{2.5},1^{7,10}]-3-dodecene. clol4.4.0.12.5.17.101-3-dodecene. 8-(anthracenyl)-tetracyclo[4.4.0.12,5.17,10]-3-dodecene, 11-phenyl-hexacyclo[6,6,1,13,6,02,70,9,14]-4-heptadecene, 6-(a-naphthyl)-bicyclo[2,2,1]-hept-2-ene, 5-(anthracenyl)-bicyclo[2,2,1]hept-2ene. 5-(biphenyl)-bicyclo[2.2.1]-hept-2-ene, 5(B-naphthyl)-bicyclo[2.2.1]hept-2-ene, 5,6-diphenyl-bicyclo[2.2.1]hept-2-ene, 5,6-dipheny ene, 9-(2-norbornen-5-yl)-carbazole, 1,4-methano-1,4,4a,4b,5,8,8a,9a-octahydrofluorene and derivatives thereof; 1,4methano-1.4.4a.9a-tetrahydrofluorene and derivatives thereof, such as 1.4-methano-1.4.4a.9a-tetrahydrofluorene, 1.4methano-8-methyl-1.4.4a.9a-tetrahydrofluorene, 1.4-methano-8-chloro-1.4.4a.9a-tetrahydrofluorene and 1.4-methano-8-bromo-1.4.4a.9a-tetrahydrofluorene; 1.4-methano-1.4.4a.9a-tetrahydrobenzofuran and derivatives thereof; 1.4methano-1,4,4a,9a-tetrahydrocarbazole and derivatives thereof, such as 1,4-methano-1,4,4a,9a-tetrahydrocarbazole and 1.4-methano-9-phenyl-1.4.4a.9a-tetrahydrocarbazole; 1.4-methano-1.4.4a.5.10.10a-hexahydrocarbracene and derivatives thereof, such as 1,4-methano-1,4,4a,5,10,10a-hexahydroanthracene; 7,10-methano-6b,7,10.10a-tetrahydrofluoracene and derivatives thereof; and compounds obtained by further adding cyclopentadiene to cyclopentadiene acenaphthylene adducts, 11,12-benzopentacyclo(6.5.1.1^{3,6}, 0^{2,7},0^{9,13}]-4-pentadecene, 11,12-benzopentacyclo(6.6.1.1^{3,6}, 0^{2,7},0^{9,13}]-4-hexadecene, 14,15-benzoheptacyclo(8,7.0.1^{2,9}, 1^{4,7},1^{11,17},0^{3,8},0^{12,16}]-5-eicosene, and cyclopentadiene-acenaphthylene adducts.

[0039] These norbornene monomers may be used either singly or in any combination thereof.

[0040] For example, a-oldrins such as 1-butene, 1-hexene, 3-methyl-1-butene, 3-methyl-1-pentene, 3-ethyl-1-pentene, 4-methyl-1-pentene, 4-methyl-1-hexene, 4-d-dimethyl-1-hexene, 4-d-dimethyl-1-pentene, 4-ethyl-1-hexene, 3-ethyl-1-hexene, 1-octene, 1-docene, 1-docene; 1-tetradecene, 1-hexadecene, 1-octadecene and 1-eicosene; non-conjugated diolefins such as 1,4-hexadiene; etc. may be used within a range of up to about 10 mol% as a molecular weight modifier.

25 (2) Ring-opening polymerization:

[0041] The ring-opening polymer of the norbornene monomer can be obtained by subjecting the norbornene monomer to ring-opening polymerisation, generally, at a polymerization temperature of -50°C to 100°C and polymerization pressure of 0 to 50 kg/cm² in a solvent or without using any solvent using, as a ring-opening polymerization catalyst, a catalyst system composed of a halide, nitrate or acetylacetone compound of a metal such as ruthenium, rhodium, palladium, osmium, ridium or platinum, and a reducing agent; a catalyst system composed of a halide acetylacetone compound of a metal such as ruthenium, vanadium, zirconium, tungsten or molybdenum, and an orgaucaluminum compound of the like.

[0042] A third component such as molecular oxygen, alcohol, ether, peroxide, carboxylic acid, acid anhydride, acid chloride, ester, ketone, nitrogen-containing compound, sulfur-containing compound, halogen-containing compound, molecular iodine or any other Lewis acid can be added to the catalyst system to improve polymerization activity and selectivity of ring-opening polymerization.

(3) Hydrogenation:

[0043] The hydrogenated product of the ring-opening polymer of the norbornene monomer can be obtained by hydrogenating the ring-opening polymer with hydrogen in the presence of a hydrogenation catalyst in accordance with a method known per se in the art.

[0044] Examples of the hydrogenation catalyst include catalysts composed of a combination of a transition metal compound and an alkyl metal compound, for example, combinations of cobalt acetate/briethylaluminum, nickel acetylacetonate/briscobutylaluminum, titanocene dichloride/n-butyllithium, zirconocene dichloride/sec-butyllithium, tetrabutoxytitanate/dimethylmagnesium, etc.

[0045] The hydrogenation reaction is generally carried out in an inert organic solvent. The organic solvent is preferably a hydrocarbon solvent because it has the excellent ability to dissolve a hydrogenated product formed therein. Aydic hydrocarbon solvent is more preferred. Examples of such a hydrocarbon solvent include aromatic hydrocarbons such as benzene and tolvene; aliphatic hydrocarbons such as n-pentane and hexame; alloycic hydrocarbons such as sydohexane and decalin; and ethers such as tetrahydrofuran and ethylene glycol dimethyl ether. At least two of these solvents may also be used in combination. The solvent may be generally the same as that used in the polymerization reaction, and so it is only necessify to add the hydrogenation catalyst to the polymerization reaction mixture as it is, so as to conduct the reaction.

[0046] The notornene polymers used in the present invention preferably have high weather resistance and resistance to deterioration by light. Therefore, it is preferred that generally at least 95%, preferably at least 95%, one preferably at least 95% of the unsaturated bonds in the main chain structures of the ring-opening polymers should be

saturated. The unsaturated bonds in an aromatic ring structure may be hydrogenated. However, it is desirable from the viewpoint of heat resistance that generally at least 20%, preferably at least 30% more preferably at least 40% of the unsaturated bonds in the aromatic ring structure should remain unhydrogenated. The unsaturated bond in the main chain structure and the unsaturated bonds in the aromatic ring structure can be distinguishably identified by "H-NMR analysis."

[0047] In order to mainly hydrogenate the unsaturated bond in the main chain structure, it is desirable that the hydrogenation reaction should be conducted at a temperature of generally -20°C to 120°C, preferably 0 to 100°C, more preferably 20 to 80°C under a hydrogen pressure of generally 0.1 to 50 kg/cm², preferably 0.5 to 30 kg/cm², more preferably 1 to 20 kg/cm².

(4) Thermoplastic norbornene polymer:

[0048] The thermoplastic norbornene polymers used in the present invention are ring-opening polymers of norbornene monomers or hydrogenated products thereof. Such a thermoplastic norbornene polymer can be typically sobtained by subjecting a norbornene monomer represented by the formula (a) to ring-opening polymerization and hydrogenating the resultant polymer as needed.

[0049] As specific examples of such a polymer, may be mentioned polymers having repeating units represented by the formula (A):

In the formula (A), R¹ to R⁶ have the same meanings as defined in the formula (a). However, in the case where the carbon-carbon double bond in the main chain is hydrogenated, non-conjugated unsaturated bonds in sichains are also hydrogenated if any. When aromatic rings are présent in side chains, it is desirable from the viewpoint of heat resistance that part or the whole of unsaturated bonds in the aromatic rings should remain unhydrogenated even after the hydrocenation.

[0050] ---- in the formula (A) means either a single bond or a double bond. When the rate of hydrogenation is as high as at least 99%, the carbon-carbon double bond in the main chain is converted into a single bond. When the hydrogenation is partially conducted, the hydrogenated norbornene polymer is in a state that a single bond and a double bond coexist in the main chain.

[0051] When the norbornene monomer represented by the formula (a1) is subjected to ring-opening polymerization, and the resultant polymer is hydrogenated as needed, a polymer having repeating units represented by the formula (A1):

is obtained.

[0052] In the formula (A1), \mathbb{R}^9 to \mathbb{R}^{20} have the same meanings as defined in the formula (a1). However, in the case where the carbon-carbon double bond in the main chain is hydrogenated, non-conjugated unsaturated bonds in side

chains are also hydrogenated if any. When aromatic rings are present in side chains, it is desirable from the viewpoint of heat resistance that part or the whole of unsaturated bonds in the aromatic rings should remain unhydrogenated even after the hydrogenation. ••••• in the formula (A1) means either a single bond or a double bond.

[0053] When the norbonnene monomer represented by the formula (a2) is subjected to ring-opening polymerization, and the resultant polymer is hydrogenated as needed, a polymer having repeating units represented by the formula (A2):

(AL)

is obtained.

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[0054] In the formula (A2), R²¹ to R³² have the same meanings as defined in the formula (a2). However, in the case where the carbon-carbon double bond in the main chain is hydrogenated, non-conjugated unsaturated bonds in side chains are also hydrogenated, when aromatic rings are present in side chains, it is desirable from the viewpoint of heat resistance that part or the whole of unsaturated bonds in the aromatic rings should remain unhydrogenated even after the hydrogenation. • • • in the formula (A2) means either a single bond or a double bond.

[0055] The molecular weight of the thermoplastic norbornene polymer used is 500 to 500,000, preferably 3,000 to 300,000, more preferably 5,000 to 250,000 when expressed by a number average molecular weight (Min) in terms of polystyrene as measured by gel permeation chromatography (GPC) using toluene as a solvent or when expressed by a number average molecular weight (Min) in terms of polystoprene as measured by GPC using cyclohexane as a solvent if the polymers its insoluble in toluene.

[0056] If the number average molecular weight (Mn) of the norbornene polymer is extremely low, the mechanical strength of the polymer becomes poor. If the molecular weight is extremely high on the other hand, the rate of graft modification with the unsaturated compound selected from the group consisting of unsaturated epoxy compounds and unsaturated carboxylic compounds cannot be heightened, and the processability of the resulting modified polymer is also deteriorated.

[0957] No particular limitation is imposed on the molecular weight distribution of the thermoplastic nothormene polymer. However, it is preferred that its ratio (Nw/Mn) of the weight average molecular weight (Mw) to the number average molecular weight (Mn) in terms of polystyrene as measured by GPC using toluene as a solvent be generally 4.0 or lower, preferably 3.0 or lower, more preferably 2.5 or lower, since the mechanical strength of the polymer is highly enhanced.

[0058] The glass transition temperature [Tg] of the thermoplastic norbornene polymer may be suitably selected as necessary for the end application intended. However, it is generally about 50 to 200°C as measured by a differential scanning calorimeter (DSC). The thermoplastic norbornene polymer preferably has a high glass transition temperature because deterioration of mechanical strength of the polymer particularly in a region of high temperatures such as a temperature upon packaging of electronic parts and the like, and a reliability testing temperature is suppressed, and its viscosity characteristics also become excellent. Even when the glass transition temperature is comparatively low, however, the heat resistance can be sufficiently enhanced by using the modified polymer in combination with a crosslinking agent to form a crosslinked polymer.

(5) Graft modification:

[0059] The graft monomer used in the present invention is an unsaturated compound selected from the group consisting of unsaturated epoxy compounds and unsaturated carboxylic compounds.

[0060] Examples of the unsaturated epoxy compounds include glycidyl esters such as glycidyl acrylate, glycidyl methacrylate and glycidyl p-styrylcarboxylate; monoglycidyl esters or polyglycidyl esters of unsaturated polycarboxylic acids such as endo-cis-bioyclo[2,2,1]hept-5-ene-2,3-dicarboxylic acid and endo-cis-bioyclo[2,2,1]hept-5-ene-2,3-dicarboxylic acid and endo-cis-bioyclo[2,2,1]hept-5-ene-2,3-dicarboxylic acid and endo-cis-bioyclo[2,2,1]hept-5-ene-2,3-dicarboxylic acid unsaturated olycidyl ether such as allyl glycidyl ether, glyc

o-allylphenol, glycidyl ether of m-allylphenol and glycidyl ether of p-allylphenol; and 2-(o-vinylphenyl)ethylene oxide, 2-(p-vinylphenyl)ethylene oxide, 2-(o-allylphenyl)ethylene oxide, 2-(p-allylphenyl)ethylene oxide, 2-(o-vinylphenyl)propylene oxide, 2-(p-vinylphenyl)propylene oxide, 2-(o-allylphenyl)propylene oxide, 2-(p-allylphenyl)-propylene oxide, p-glycidylstyrene, 3,4-epoxy-1-butene, 3,4-epoxy-3-methyl-1-butene, 3,4-epoxy-1-pentene, 3,4-epoxy-3-methyl-1-pentene, 5 6-expoxy-1-hexene, vinylcyclohexene monoxide and allyl-2.3-epoxycyclopentyl ether. Of these, the allyl glycidyl esters and allyl glycidyl ethers are preferred, with the allyl glycidyl ethers being particularly preferred.

[0061] As the unsaturated carboxylic compounds, may be used unsaturated carboxylic acids or derivatives thereof. As examples of such unsaturated carboxylic acids, may be mentioned acrylic acid, maleic acid, fumaric acid, tetrahydrophthalic acid, itaconic acid, citraconic acid, crotonic acid, isocrotonic acid and nadic acid (endo-cis-bicy-10 clo[2,2,1]hept-5-ene-2,3-dicarboxylic acid). As examples of derivatives of the above-described unsaturated carboxylic acids, may be mentioned unsaturated carboxylic acid anhydrides, unsaturated carboxylic acid halides, unsaturated carboxylic acid amides, unsaturated carboxylic acid imides and ester compounds of unsaturated carboxylic acids. As specific examples of such derivatives, may be mentioned malenyl chloride, maleimide, maleic anhydride, citraconic anhydride, monomethyl maleate, dimethyl maleate and glycidyl maleate. Of these, the unsaturated dicarboxylic acids or acid anhydrides thereof are preferred, with maleic acid and nadic acid or acid anhydrides thereof being particularly preferred.

[0062] These graft monomers may be used either singly or in any combination thereof. [0063] The modified thermoplastic norbornene polymers according to the present invention can be produced by subjecting such a graft monomer as described above and the thermoplastic norbornene polymer to graft modification by using any of various processes conventionally known. Examples of the processes include (1) a process comprising melting a thermoplastic norbornene polymer and adding a graft monomer to the melt to graft polymerize them, and (2) a process comprising dissolving a thermoplastic norbornene polymer in a solvent and then adding a graft monomer to the solution to graft copolymerize them. In addition, methods for producing the modified thermoplastic norbornene polymers include a method in which a graft monomer is mixed with an unmodified thermoplastic norbornene polymer in such a manner that the rate of graft modification of the resulting polymer reaches the desired rate, thereby modifying the polymer, and a method in which a graft-modified thermoplastic norbornene polymer having a high rate of graft moditication is prepared in advance, and the modified thermoplastic norbornene polymer having the high rate of graft modification is diluted with an unmodified thermoplastic norbornene polymer to produce a graft-modified thermoplastic norbornene polymer having the desired rate of graft modification. In the present invention, any production process or method may be adopted.

[0064] In order to efficiently graft copolymerize the graft monomer, it is generally preferred to carry out a reaction in the presence of a radical initiator.

[0065] As the radical initiator, for example, organic peroxides, organic peresters, etc. may be preferably used. As specific examples of such radical initiators, may be mentioned benzoyl peroxide, dichlorobenzoyl peroxide; dicumyl perox-2,5-dimethyl-2,5-di(tert-butyl peroxybenzoate)hexyne-3; 1,4-bis(tert-butyl di-tert-butyl peroxide. 35 ide. peroxyisopropyl)benzene, lauroyl peroxide, tert-butyl peracetate, 2,5-di(tert-butyl peroxy)hexyne-3, 2,5-dimethyl-2,5di(tert-butyl peroxy)hexane, tert-butyl perbenzoate, tert-butyl peracetate, tert-butyl perisobutyrate, tert-butyl per-secoctoate, tert-butyl perpivalate, curryl perpivalate and tert-butyl perdiethylacetate.

[0066] In the present invention, azo compounds may also be used as radical initiators. As specific examples of the 40 azo compounds, may be mentioned azobisisobutyronitrile and dimethyl azoisobutyrate.

[0067] Of these, benzoyl peroxide, and dialkyl peroxides such as dicumyl peroxide, di-tert-butyl peroxide, 2,5-dimethyl-2,5-di(tert-butyl peroxy)hexyne-3, 2,5-dimethyl-2,5-di(tert-butyl peroxy)hexane and 1,4-bis(tert-butyl peroxyisopropyl)benzene are preferably used as the radical initiators.

[0068] These radical initiators may be used either singly or in any combination thereof. A proportion of the radical initiator used is generally within a range of 0.001 to 10 parts by weight, preferably 0.01 to 5 parts by weight, more preferably 0.1 to 2.5 parts by weight per 100 parts by weight of the unmodified thermoplastic norbornene polymer.

[0069] No particular limitation is imposed on the graft-modifying reaction, and the reaction may be carried out in accordance with a method known per se in the art. The reaction is conducted at a temperature of generally 0 to 400°C, preferably 60 to 350°C. The reaction time is generally within a range of 1 minute to 24 hours, preferably 30 minutes to

(6) Modified thermoplastic norbornene polymer:

[0070] The molecular weight of the modified thermoplastic norbornene polymer is within a range of 500 to 500,000, preferably 3,000 to 300,000, more preferably 5,000 to 250,000 when expressed by a number average molecular weight (Mn) in terms of polystyrene as measured by gel permeation chromatography (GPC) using toluene as a solvent or when expressed by a number average molecular weight (Mn) in terms of polyisoprene as measured by GPC using cyclohexane as a solvent if the modified thermoplastic norbornene polymer is insoluble in toluena.

[0071] When the modified thermoplastic norbonnene polymer is used as a high-concentration solution, a composition with a great amount of compounding additives or an impregnating solution for reinforcing base materials, its number average molecular weight (Mm) is controlled within a range of generally 500 to 20,000, preferably 3,000 to 20,000, more preferably 5,000 to 19,500.

[0072] On the other hand, when the modified thermoplastic notbornene polymer is used in application fields such as an interlayer insulating film, its number average molecular weight (Mn) is generally controlled so as to exceed 20,000, and its upper limit is at most 500,000, preferably at most 300,000, more preferably at most 250,000.

[0073] If the number average molecular weight (Mn) of the modified thermoplastic norbornene polymer is extremely low, the mechanical strength of the polymer becomes poor. If the molecular weight is extremely high on the other hand, the viscosity of the modified thermoplastic norbornene polymer when dissolved in a solvent is increased, and so the concentration of solids including compounding additives cannot be heightened, and its processability is also deteriorated. It is hence not preferred to use the modified thermoplastic norbornene polymer having such an extremely low or high molecular weight.

[0074] The molecular weight distribution of the modified thermoplastic norbonnene polymer may be suitably selected to as necessary for the end application intended. However, it is preterred that its ratio (NwMn) of the weight average molecular weight (Nw) to the number average molecular weight (Nm) as measured by GPC under the above-described conditions be generally 4.0 or lower, preferably 3.5 or lower, more preferably 2.5 or lower, since the mechanical strength of the polymer is particularly high. In mane cases, MwMn is 2.0 or lower.

10075] The rate of graft modification of the modified thermoplastic norbornee polymer used in the present invention 20 is suitably selected as necessary for the end application intended. However, it is generally within a range of 10 to 100 mol%, preferably 15 to 50 mol%, more preferably 15 to 35 mol% based on the total number of monomer units in the polymer. The modified thermoplastic norbornene polymer the rate of graft modification of which falls within this range is preferred because the electrical properties such as dielectric constant, adhesion property to metals, silicon wafers and the like, ability to uniformly disperse various kinds of compounding additives therein, etc. are balanced with one another at a high level. If the rate of graft modification is too low, its adhesion property to other materials and as metals and silicon wafers becomes deteriorated, and in its turn, the heat resistance, durability and the like also become deteriorated.

(0076) The rate of graft modification is represented by the following equation (1):

Rate of graft modification (mol%) = (X/Y) x 100 (1)

wherein

30

- X: the total number of moles of the modifying group introduced into the polymer by grafting of the unsaturated compound; and
 - Y: the total number of monomer units in the polymer (weight average molecular weight of the polymer/ average molecular weight of the monomer).

[0077] X can be said to be the total number of moles of modifying residue introduced by the graft monomer and can be determined by ¹H-NMR. Y is equal to a ratio of the weight average molecular weight (Nw) of the polymer/the molecular weight of the monomer. In the case of copolymerization, the molecular weight of the monomer is defined as an average molecular weight of monomers.

[0078] The modified thermoplastic norbornene polymer according to the present invention is a graft-modified polymer having a structure that the unsaturated compound is bonded to the thermoplastic norbornene polymer as a backbone polymer by a graft reaction. The repeating unit in the grafted molety is determined by the kind of the graft monomer (unsaturated compound).

[0079] The modified thermoplastic norbornene polymers according to the present invention leature that (1) the heat resistance and electrical properties such as delectric constant are fully excellent, (2) the concentration their solutions can be sufficiently heightened, (3) compounding additives can be uniformly dispersed at a high concentration in their solutions, and the number of kinds of compounding additives capable of being uniformly dispersed therein can be increased, and (4) since the rate of graft modification is high, prepregs, laminates, interlayer insulating films, overcoats and the like obtained by using the modified thermoplastic norbornene polymers are excellent in addision property (peel strength) to other materials such as metals (metal folis, metallized films, metallized infirms, etc.) and sitted on wafers.

55 Crosslinking polymer composition:

[0080] The crosslinking polymer composition according to the present invention features that it contains at least the above-described modified thermoplastic norbonnene polymer and a crosslinking agent as essential components.

[0081] No particular limitation is imposed on the method for crosslinking the crosslinking polymer composition according to the present invention. For example, the crosslinking can be conducted by using heat, light, radiation and/or the like. The kind of the crosslinking agent is suitably selected according to such means. When the above described modified norbornene polymer is used, the ability to uniformly disperse various crosslinking agents therein also becomes good. Into the crosslinking polymer composition according to the present invention, as needed, a crosslinking aid, a flame relatedant, other compounding actifities, a solvent, etc. may be blended in addition to the crosslinking agent.

(1) Crosslinking agent:

[0082] In order to crosslink the modified thermoplastic norbornens polymer according to the present invention, for example, a method of crosslinking the polymer by irradiation of radiation is also included. However, a method of crosslinking the polymer by blending a crosslinking agent is generally adopted. No particular limitation is imposed on the crosslinking agent. However, (D an organic peroxide, 20 a crosslinking agent capable of exhibiting its effect by light, or the like is used.

Organic peroxide:

[0083] Examples of the organic peroxide include ketone peroxides such as methyl ethyl ketone peroxide and cyclohexanone peroxide; peroxyketals such as 1.1-bis (1-buyl peroxy)-3.3-brimethyl-loyclohexane and 2.2-bis[1-buyl peroxy)-burner; hydroperoxides such as 1-buyl hydroperoxide and 2.5-dimethylhexane-2.5-dihydroperoxide; dialtyl peroxides such as dicumyl peroxide, 2.5-dimethyl-2.5-di(1-buyl) peroxy)hexpress; diacyl peroxides such as octanoly peroxide and isobutyryl peroxide; and peroxyesters such as peroxydicarbonate. Of these, the dialtyl peroxides are preferred from the viewpoint of performance of the crosslinked resin, it is preferred to change the kind of the alityl group according to the forming or molding temperature.

The organic peroxides may be used either singly or in any combination thereof. The amount of the organic peroxide blanded is generally 0.001 to 30 parts by weight, preferably 0.01 to 25 parts by weight, more preferably 1 to 20 parts by weight per 100 parts by weight of the modified thermorplastic nothomene polymer. The blending amount within this range is preferred because crosslinkability of the resulting composition, and properties of the crosslinked resin, such as electrical properties, chemical resistance and water resistance, are balanced with one another at a high level.

Crosslinking agent capable of exhibiting its effect by heat:

[0085] No particular limitation is imposed on the crosslinking agent capable of exhibiting its effect by heat so far as it can cause a crosslinking reaction by heating. Examples thereof include aliphatic polyamines such as diamines, triamines and still higher polyamines, alicyclic polyamines, aromatic polyamines, bisazides, acid anhydrides, dicarboxylic acids, diols, polyhydric phenols and polyamides. Specific examples thereof include aliphatic polyamines such as hexamethylenediamine, triethylenetetramine, diethylenetriamine and tetraethylenepentamine; alicyclic polyamines such as diaminocyclohexane, 3(4),8(9)-bis(aminomethyl)tricyclo[5,2,1,0^{2,6}]decane, 1,3-(diaminomethyl)cyclohexane, menthenediamine, isophoronediamine, N-aminoethylpiperazine, bis(4-amino-3-methylcydohexyl)methane and bis(4-aminocyclohexyl)methane; aromatic polyamines such as 4.4'-diaminodiphenyl ether, 4.4'-diaminodiphenylmethane, α.α'-bis(4aminophenyl)-1,3-diisopropylbenzene, a,a-bis(4-aminophenyl)-1,4-diisopropylbenzene, 4,4-diaminodiphenyl sulfone and m-phenylenediamine; bisazides such as 4,4'-bisazidobenzal(4-methyl)cyclohexanone, 4,4'-diazido-chalcone, 2,6bis(4'-azidobenzal)cyclohexanone, 2,6-bis-(4'-azidobenzal)-4-methylcyclohexanone, 4,4'-diazido-diphenyl sulfone, 45 4,4 diazidodiphenylmethane and 2,2 diazidostilbene; acid anhydrides such as phthalic anhydride, pyromellitic anhydride, benzophenone-tetracarboxylic acid anhydride, nadic anhydride, 1,2-cyclohexanedicarboxylic acid and maleic anhydride-modified polypropylene; dicarboxylic acids such as fumaric acid, phthalic acid, maleic acid, trimellitic acid and himic acid; polyhydric phenols such as phenol novolak resins and cresol novolak resin; polyhydric alcohols such as tricyclodecanediol, diphenylsilanediol, ethylene glycol and derivatives thereof, diethylene glycol and derivatives thereof, and triethylene glycol and derivatives thereof; and polyamides such as nylon 6, nylon 66, nylon 610, nylon 11, nylon 612, nylon 12, nylon 46, methoxymethylated polyamide, polyhexamethylenediamine terephthalamide and polyhexamethylene isophthalamide;.

[0086] These crosslinking agents may be used either singly or in any combination thereof. Of these, the aromatic polyamines, acid arhydrides, polyhydric phenois and polyhydric alcohols are preferred for reason of providing a crosslinked resin excellent in heat resistance, mechanical strength, adhesion property and dielectric properties (low delectric constant and dielectric loss tangent). Among others, 4,4-diaminodiphenylmethane (aromatic polyamine) and polyhydric alcohols are particularly preferred.

[0087] No particular limitation is imposed on the amount of the crosslinking agent blended. From the viewpoints of

being able to efficiently conduct a crosslinking reaction and improve the physical properties of the resulting crosslinking research area and poll of 20 parts by weight, preferably 0.01 to 25 parts by weight, more preferably 1 to 20 parts by weight per 100 parts by weight of the modified thermoplastic nor-bornene polymer. If the amount of the crosslinking agent is too little, the resulting composition becomes hard to undergo crosslinking, and so sufficient heat resistance and solvent resistance cannot be imparted to the composition. On the contrary, any amount too great results in a crosslinked resin lowered in properties such as water-absorption properties and dielectric properties. It is hence not preferable to use the crosslinking agent in any amount outside the above range. Therefore, the blending amount within this range is preferred because these properties are balanced with one another at a high level.

10 [0088] As needed, a crosslinking accelerator (hardening accelerator) may also be blended to enhance the efficiency of the crosslinking reaction.

[089] As examples of the hardening accelerator, may be mentioned amines such as pyridine, benzyldimethylamine, triethranolamine, triethylamine and imidazotes. The hardening accelerator is added in order to regulate the rate of the crosslinking reaction. No particular limitation is imposed on the amount of the hardening accelerator blended. However, it is used within a range of generally 0.1 to 30 parts by weight, preferably 1 to 20 parts by weight per 100 parts by weight of the thermoplastic norbornene polymer. The blending amount within this range is preferred because crosslinking density, dielectric properties, water absorption and the like of the crosslinked resin are balanced with one another at a high level. Among others, imidazotes are preferred in that a crosslinked resin excellent in dielectric properties.

3 Crosslinking agent capable of exhibiting its effect by light:

[0090] No particular limitation is imposed on the crossinking agent (hardener) capable of exhibiting its effect by light so far as it is a photoreactive substance which reacts with the modified thermoplastic notomene polymer by irradiation of actinic rays such as ultraviolet rays such as ultraviolet rays such as grays, h rays or i rays, far ultraviolet rays, X rays, or electron rays to form a crosslinked compound. Examples thereof include aromatic bisazide compounds, photo-induced amine generators and photo-induced actionerators.

[0091] Specific typical examples of the aromatic bisazide compounds include 4,4'-diazidochalcone, 2,6-bis(4'-azido-benzal)cydohexanone, 2,6-bis(4'-azido-benzal)cydohexanone, 4,4'-diazidodiphanyl sulfone, 4,4'-diazidoben-szophenone, 4,4'-diazidophenyl, 2,7-diazidofluorene and 4,4'-diazidophenylmethane. These compounds may be used either singly or in any combination thereof.

[0092] Specific examples of the photo-induced amine generators include o-nitrobenzyloxycarbonylcarbamates, 2,6-dinitrobenzyloxycarbonylcarbamates and a_cdimethyloxycarbonylcarbamates of a cornatic amines or aliphatic amines. More specifically, there may be mentioned o-nitrobenzyloxycarbonylcarbamates of aniline, cyclohexylamine, piperidine, hexamethylenediamine, triethylenetetramine, 1,3-(diaminomethyl)cyclohexane, 4,4'-diaminodiphenyl ether, 4,4'-diaminodiphenylmethylenediamine and the like. These compounds may be used either singly or in any combination thereof.

[0033] The photo-induced acid generator is a substance which forms a Bryansted acid or Lewis acid upon exposure to actinic rays. Examples thereof include onium selfs, helogenated organic compounds, quinonedide compounds, ac., α-bis(sultonyi)diazomethane compounds, α-carbonyl-α-sulfonyl-diazomethane compounds, sudance compounds, organic acid ester compounds, organic acid ester compounds, organic acid ester compounds, organic acid ester compounds, substance compounds, organic acid ester compounds, compounds, organic acid ester compounds, substance compounds, acid ester compounds such as benzoin ester photo-crosslinking agents, may be mentioned benzoin alkyl ether compounds such as benzoinent produced acid ester compounds such as benzoinent ester and benzoin isobutyl ether; benzophenonen compounds such as 2-diethoxyacetophenone, and acid ester acid

points of being able to efficiently conduct the reaction with the modified thermoplastic norbornene polymer, not impairing the physical properties of the resulting crosslinked resin, and being profilable, however, it is generally within a range of 0.001 to 30 parts by weight, preferably 0.01 to 25 parts by weight, mover perferably 1 to 20 parts weight per 100 parts by weight of the modified thermoplastic norbornene polymer. If the amount of the photoreactive substance added is too little, the resulting composition becomes hard to undergo crosslinking, and so sufficient heat resistance and solvent resistance cannot be imparted to the composition. On the other hand, any amount too great results in a crosslinked

resin lowered in properties such as water-absorption property and dielectric properties. It is hence not preferable to use the photoreactive compound in any amount outside the above range. Therefore, the blending amount within this range is preferred because these properties are balanced with one another at a high level.

(2) Crosslinking aid:

[0096] In the present invention, it is preferred to use a crosslinking aid, because the crosslinkability and the dispersibility of the compounding additives can be more enhanced.

[0097]. No particular limitation is imposed on the crosslinking aid used in the present invention. Publicly known comto pounds disclosed in Japanese Patent Application Laid-Open No. 34924/1987 and the like may be used. Examples
thereof include oxime introso type crosslinking aids such as quinone dioxime, benzoquinone dioxime and p-nitrosophenol; maleimide type crosslinking aids such as N.N-m-phenylenebismaleimide; allyl type crosslinking aids such as
diallyl phthalate, triallyl cyanurate and triallyl isocyanurate; methacrylate type crosslinking aids such as ethylene glycol
dimethacrylate and trimethylolpropane trimethacrylate; and vinyl type crosslinking aids such as vinyltoluene, ethylvinylbenzene and divinylbenzene. Of these, the allyl type crosslinking aids and methacrylate type crosslinking aids are preferred because they make it easy to unformly disposerse compounding additives.

[0098] The amount of the crosslinking aid added is suitably selected according to the kind of the crosslinking agent used. However, it is generally 0.1 to 10 parts by weight, preferably 0.2 to 5 parts by weight per part by weight per crosslinking agent. If the amount of the crosslinking added is too little, the resulting composition becomes hard to undergo crosslinking. On the contrary, any amount too great results in a crosslinked resin having a possibility that its electrical properties, water resistance, moisture resistance and the like may be deteriorated.

(3) Flame retardant:

25 [0099] The flame retardant is not an essential component. However, it is preferred that the flame retardant be added to the modified thermoplastic norbornene polymer compositions when the composition is used for electronic parts. No particular limitation is imposed on the flame retardant. However, those which undergo none of decomposition, denaturation and deterioration by the crosslinking agent (hardener) are preferred.

[0100] Various kinds of chlorine- or bromine-containing flame retardants may be used as the halogen-containing flame retardants. From the vicewpoints of flameproofing effect, heat resistance upon toorning or modification in resins and influence on the physical properties of the resins, however, the following flame retardants may be preferably used. Namely, preferable examples thereof include hexabromobenzene, pentabromo-ethythenzene, hexabromobiphenyl, decabromodiphenyl, hexabromodiphenyl exide, tetrabromophinalinide, ethylenebisty hexabromodiphenyl exide, between [for example, tetrabromophinalinide, ethylenebisty-hexabromodiphenyl exide, ethylenebisty-hidromophenyl ethylenebisty

(0101) These flame retardants may be used either singly or in any combination thereof. The amount of the flame retardant added is generally 3 to 150 parts by weight, preferably 10 to 140 parts by weight per flow parts by weight of the modified thermoplastic norbornene polymer.

[0102] As a flame retardant auxiliary for causing the flame retardant to more effectively exhibit its flameproofing effect, for example, an antimonial flame retardant auxiliary such as antimony trioxide, antimony pentoxide, sodium antimonate or antimony trichloride may be used. These flame retardant auxiliaries are used in a proportion of generally 1 to 30 parts by weight, preferably 2 to 20 parts by weight or 100 parts by weight of the flame retardant.

(4) Filler:

[0103] In order to improve mechanical strength (toughness) and reduce coefficient of linear expansion in particular, a a filler may be blended into the crosslinking polymer compositions according to the present invention. Examples of the filter include inorganic and organic fillers.

[0104] No particular limitation is imposed on the inorganic fillers. Examples thereof include calcium carbonate (precipitated calcium carbonate, heavy or pulverized calcium, special calcium type fillers), clay (aluminum silicate; fine

nepheline syenite powder, catcined clay, silane-modified (ay), late, silica, alumina, diatomaceous earth, quartz sand, pumice powder, pumice balloors, silet powder, mica powder, asbestos, alumina colloid (alumina sol), alumina white, aluminum sullitate, barium sullate, lithopone, calcium sullate, molybdenum disulfide, graphite, glass libers, glass beads, glass flake, foamed glass beads, ly sah beads, volcanic glass balloons, synthetic inorganic balloons, monocrystalline potassium titanate, carbot fibers, carbon balloons, anthractic culm, artificial cryolite, titanium oxide, magnesium oxide, basic magnesium carbonate, dolomite, potassium titanate, calcium, sulfile, mica, asbestos, calcium silicate, montmorillorite, bentonite, graphite, aluminum powder, molybdenum sulfile, borno fibers and silicon carbide flows.

[0105] Examples of the organic fillers include polyethylene fibers, polypropylene fibers, polyester fibers, polyamide fibers, fluorocarbon fibers, ebonite powder, thermosetting resin balloons, saran balloons, shellac, wood flour, cork powder, polyvinity alcohol fibers, cellulose powder and wood pulp.

(5) Other compounding additives:

[0106] To the crosslinking polymer compositions according to the present invention, may be added proper amounts of other compounding additives such as heat stabilizers, weathering stabilizers, leveling agents, antistatic agents, slip agents, antiblocking agents, anti-logging agents, lubricants, dyes, pigments, natural oil, synthetic oil and wax, as needed.

[0107] Specific examples thereof include phenolic antioxidants such as tetraksignethylene-3(3,5-di-tbutyl-4-hydroxypheny)) propionate]methane, alkyl p-(3,5-di-tbutyl-4-hydroxypheny)) propionate]methane, alkyl p-(3,5-di-tbutyl-4-hydroxypheny)) propionate]methane, alkyl p-(3,5-di-tbutyl-4-hydroxypheny)) propionate]; prosphoric stabilizers such as trisnonylpheny) phosphite, tris(2,4-di-tbutylpheny)) phosphite and tris(2,4-di-tbutylpheny)) phosphite; attry acid metal salts such as zinc stearate, calcium stearate and column 12-hydroxy-stearate; polyhydric alcohol fatty acid esters such as glycerol monostearate, pentaerythritol monostearate, pentaerythritol distearate and pentaerythritol tristearate; synthetic hydrotalcite; amine type antistatic agents; leveling agents for paints, such as fluorine-containing nonionic surfactants, special acrytic resin type leveling agents and silicone type leveling agents; coupling agents such as siliane coupling agents, thanate coupling agents, aluminum-containing coupling agents and zircoaluminate coupling agents; plasticizers; and colorants such as pigments and dyes.

[0108] These compounding additives may be used either singly or in any combination thereof. The compounding proportions thereof are suitably selected according to their respective functions and the end application intended.

30 [0109] Into the crosslinking polymer compositions, other kinds of thermoplastic resins such as polycarbonate, polystyrene, poly(phenylene sulfide), poly(ether imide), polyester, polyamide, polyarylate and polysulfone; elastomers or rubbery polymers; and the like may be blended for the purpose of controlling the mechanical properties and flexibility of the composition.

35 (6) Solvent:

[0110] In the present invention, the modified norbornene polymer may be dissolved in a solvent to prepare an impregnating solution for prepregs, produce a sheet by a solution casting method, or form a film by a coating method.

[0111] In the case where the modified thermoplastic norbornene polymer is dissolved in a solvent, examples of the solvent used include aromatic hydrocarbons such as bluene, xylene and ethylbenzene; aliphatic hydrocarbons such as n-pentane, hexame and heptane; alicydic hydrocarbons such as cyclohexane; and halogenated hydrocarbons such as chlorobenzene, dichlorobenzene and trichlorobenzene.

[0112] The solvent is used in an amount sufficient to uniformly dissolve or disperse the modified thermoplastic norbornene polymer and the individual components optionally blended therein.

Molding, prepreg, laminate, interlayer insulating film, etc.:

[0113] The crosslinking polymer composition according to the present invention may be molded in the desired form and then crosslinked to form a crosslinked molding. The crosslinking polymer composition is molded after dissolving it in a solvent to as not to cause deterioration of moldability due to crosslinking in the course of molding, or by melting it at a temperature at which it undergoes no crosslinking, or crosslinking proceeds only at a sufficiently low rate. Specifically, the norborpene polymer composition dissolved in a solvent is cast, and the solvent is removed to form a sheet, or a base material is impregnated with the composition dissolved in the solvent to conduct molding.

[0114] The crosslinking polymer composition according to the present invention can be moded into various parts in ss accordance with various modifing processes. Examples of the molding processes in this case include (0) a process in which the composition is processed into a molding in a state of a thermoplastic resin by injection molding, press molding, compression molding or the like, (2) a process in which has oblution with the composition dissolved in an organic solvent is processed into a molding by potting or cast molding while removing the solvent, and (3) a process in which the

composition is processed into a thermoset molding by transfer molding or the like.

[0115] Further, the crosslinking polymer composition according to the present invention can be formed into a film by a coating method.

5 (1) Prepreg:

[0116] A prepreg which is one of specific examples of the crosslinked moldings is produced by uniformly dissolving or dispersing the modified thermoplastic notocreene polymer, crosslinking agent and various compounding additives in a solvent such as toluene, cyclohexane or xylene, impregnating a reinforcing base material with the solution or dispersion and then drying the base material to remove the solvent. In general, the prepreg is preferably produced so as to give a thickness of about 50 to 500 µm.

[0117] The amount of the solvent used is controlled in such a manner that a solids concentration amounts to generally 1 to 90 wt.%, preferably 5 to 85 wt.%, more preferably 10 to 80 wt.%.

[0118] Examples of usable reinforcing base materials include paper base materials (finder paper, kraft paper, etc.).
15 glass base materials (glass cioth, glass mat, glass paper, quurtz fibers, etc.) and synthetic resin fiber base materials (polyseter fibers, Aramide fibers, etc.). These reinforcing base materials may be surface treated with a treating agent such as a silane coupling agent. These reinforcing base materials may be used either singly or in any combination thereof.

[0119] The amount of the modified thermoplastic norbornene polymer composition to the reinforcing base material is suitably selected as necessary for the end application intended. However, it is generally 1 to 90 wt.%, preferably 10 to 60 wt.% based on the reinforcing base material.

(2) Sheet:

25 [0120] No particular limitation is imposed on a process for producing a sheet. However, a casting process is generally used. For example, the crosslinking polymer composition according to the present invention is dissolved or dispersed in a solvent such as toluene, xylene or cyclohexane so as to give a solids concentration of about 5 to 50 Mt.%, the solution or dispersion is cast or coated on a smooth surface, the solvent is removed by drying or the like, and the dried product is separated from the smooth surface to obtain a sheet. When the solvent is removed by drying to select a method by which foaming by rapid drying does not occur. For example, it is only necessary to volatilize the solvent to a certain extent at a low temperature and then raise the temperature so as to sufficiently volatilize the solvent. [0121] As the emooth surface, may be used a planished metal plate, a carrier film made of a resin, or the like. When the resin-made carrier film is used, a solvent to be used and drying conditions are determined taking the solvent resistance and heat resistance of a material of the carrier film into consideration.

35 [0122] Sheets obtained by the casting process generally have a thickness of about 10 µm to 1 mm. These sheets can be used as Interlayer Insulating films, films for forming moistureproof layers, etc. by crosslinking them. They may also be used in the production of laminates which will be described subsequently.

(3) Laminate:

[0123] A laminate is obtained by stacking a plurality of the above-described prepregs and/or uncrossilinked sheets on one another and hot-pressing them, thereby crosslinking and mutually fusion-bonding them into a necessary thickness. When a laminated sheet is used as a circuit board, a circuit is formed by, for example, laminating an electrically conductive layer for wiring composed of a metal fail or the like, or etching the surface. The electrically conductive layer for wiring was be laminated not only on the outer surface of the laminated sheet as a finished article, but also in the interior of the laminated sheet according to the purpose. In order to prevent warpage upon a secondary processing such as etching its preferred to laminate laminating materials in combination so as to vertically symmetries. For example, the surfaces of the stacked prepregs and/or sheets are heated to a fusion-bonding temperature according to the modified thermoplastic nothernene polymer used or higher, generally about 150 to 30°C, and they are presessed under about 30 to 80 kg/cm², thereby crosslinking and mutually fusion-bonding the respective layers to obtain a laminated sheet.

[0124] Other methods for applying a metal to these Insulating layers or a base material include vapor deposition, electroplating, sputtering, ion plating, spraying and layering. Examples of metals commonly used include copper, nickel, tin, silver, gold, aluminum, platinum, tinatum, rice and chromium. Copper is oftenest used in circuit boards.

(4) Crosslinking:

[0125] In the present invention, a molding is crosslinked by itself or in the form of a laminate to obtain a crosslinked

molding. The crosslinking may be conducted in accordance with a method known per se in the art. Examples thereof include a method of irradiating a molding with radiation, a method of heating a molding to a certain temperature or higher in the case where an organic peroxide has been blended, and a method of irradiating a molding with rays such as ultraviolet rays in the case where a photo-crosslinking agent has been blended. Of these, the method in which the organic peroxide is blended, and the molding is heated to crosslink is preferred, since the method can be conducted with ease.

[0126] A temperature at which a crosslinking reaction is caused is mainly determined by a combination of an organic peroxide and a crosslinking aid. However, the crosslinking is conducted by heating a molding to a temperature of generally 80 to 350°C, preferably 120 to 300°C, more preferably 150 to 250°C. Crosslinking time is preferably 120 to 300°C, more preferably 150 to 250°C. Crosslinking time is preferably 120 to 300 minutes, more preferably 20 to 60 minutes. When a crosslinking agent (hardener) capable of exhibiting its effect by heat is used as the crosslinking agent (rosslinking when a photocrosslinking agent to selfect by heat is used as the crosslinking agent cosslinking agent (bardener) capable of exhibiting its used as the crosslinking agent, crosslinking can be caused by heating. When a photocrosslinkable moldings are laminated and then crosslinked, fusion bonding and crosslinking occur between the respective layers, thereby obtaining an integral crosslinked molding.

(5) Crosslinked molding:

[0127] Examples of crosslinked moldings according to the present invention include laminated sheets, circuit boards, interlayer insulating tilms and films for forming moisture proof layers. The crosslinked moldings according to the present invention generally have a water absorption of at most 0.03%, and a dielectric constant of 2.0 to 4.0 and a dielectric loss tangent of 0.0005 to 0.005 as measured at a frequency of 1 MHz. Therefore, the moldings according to the present invention are superior in moisture resistance and electrical properties to the conventional thermoset moldings. The heat resistance of the crosslinked moldings according to the present invention is equal to that of the conventional thermoset moldings. Accordingly, even when a laminated sheet on which a copper foil has been laminated is brought into contact with a solder of 260°C for 30 seconds or with a solder of 300°C for 1 minute, shormanily such as delamination of the metal layer such as the copper foil and/or occurrence of bilster is not observed. In addition, the crosslinked moldings according to the present invention are excellent in adhesion property to the copper foil as demonstrated by a peel strength of generally 1.4 to 2.7 kg/cm². This is far improved compared with the conventional thermoplastic norborneer resirs. From these results, the laminated sheet which is a crosslinked molding according to the present invention is suitable for use as a circuit board.

[0128] Moldings obtained by using the crosslinking polymer compositions according to the present invention as thermoplastic resins are useful as electronic parts such as connectors, relays and capacitors; electronic parts such as injection-molded sealing parts for semiconductor devices such as transistors, ICs and LSIs; and body tubes for optical lenses and parts such as polygon mirrors and F6 mirrors.

[0129] When the crosslinking polymer compositions according to the present invention are used in a state dissolved in an organic solvent, they are useful for uses such as sealing materials for potting and cast molding.

[0130] When the crosslinking polymer compositions according to the present invention are used as transfer molding materials, they are useful as packaging (sealing) materials for semiconductor devices.

[0131] The crosslinking polymer compositions according to the present invention can be used in the form of a film. In the case where they are used as films, there are cases () where the crosslinking polymer composition is disclosed in an organic solvent, and the solution is formed into a film by a casting process or the like in advance to use it, and Q where the solution is spelled, and the solvent is then removed to use a film formed as an overcoat. More specifically, such films are useful as, for example, insulating sheets for laminated sheets, interlayer insulating films, liquid sealing materials for semiconductor devices, overcoating materials etc.

(EXAMPLES)

55

[0132] The present invention will hereinafter be described specifically by the following Examples and Comparative Examples. Incidentally, physical properties were measured in accordance with the following methods:

- (1) The glass transition temperature was measured in accordance with the differential scanning calorimetry (DSC method).
- (2) The molecular weight was determined in terms of polystyrene as measured by gel permeation chromatography
- (GPC) using toluene as a solvent unless expressly noted.
- (3) The rates of hydrogenation in the main chain and side chain were determined by ¹H-NMR.
- (4) The total number of moles of modifying residue introduced by an unsaturated epoxy compound or unsaturated carboxylic compound was determined by ¹H-NMR, and the rate of graft modification was calculated out in accord-

ance with the above-described equation.

- (5) The flame retardancy was determined in accordance with the US UL-94 test standard.
- (6) The dielectric constant and dielectric loss tangent were determined at 1 MHz in accordance with JIS K 6911.
- (7) The copper foil peeling strength was determined in the following manner. Namely, a specimen 20 mm wide and 100 mm long was out out of a resin laminate sample, parallel notches were cut at an interval of 10 mm in the copper foil surface of the specimen, and the copper foil was continuously peeled off at a rate of 50 mm/min in a direction perpendicular to the surface by a tensile tester. The copper foil peeling strength was expressed in terms of the minimum stress value at this time.
- (8) The adhesion property was determined by conducting a cross-cut peel strength test in accordance with JIS K 5400.
- (9) The durability was determined by leaving a test sample to stand for 1,000 hours under conditions of 90°C and 95% relative humidity to observe whether visual abnormality such as blister, the corrosion and/or tarnishing of copera and the like occurred or not.
- (10) The heat resistance was determined in the following manner. After a test sample was brought into contact with a solder of 300°C for 1 minute, the appearance of the sample was observed to evaluate it in accordance with the following standard:
- Good: Neither delamination nor blister was observed:
- Poor: Detamination or blister was observed.

(Example 1)

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- [0133] A 1-liter flask purged with nitrogen was charged with 5 g of 8-ethyletracyclo(4.4.0.12⁸, 17-10⁹, 3-dodecene (i.e., 6-methyl-1.4; 3-d-dimehano-1.4, 4.5, 5.7, 8.8 octahydronaphthalene; hereinafter reterred to as "ETD") and 120 g of 25 toluene, followed by addition of 0.287 mmol of triisobutylaluminum and 0.287 mmol of isobutyl alcohol as polymerization catalysts, and 3.83 mmol of 1-hexene as a molecular weight modifier. To the mixture, 0.057 mmol of tungsten hexachloride was added, and stirring was conducted at 40°C for 5 minutes. Thereafter, 45 g of ETD and 0.086 to the mol of tungsten hexachloride were continuously added dropwise to the reaction system over about 30 minutes. After completion of the addition, stirring was continued for addition, also minutes to complete polymerization.
- 10134] This polymerization reaction mixture was transferred to a 1-fiter autoclave, and 160 g of foluene were added thereto. After a mixture of 0.5 g of nickel acetylacetonate and 5.15 g of a 30 nt.% foluene solution of trilisothylaminrum was then added, and the interior of the autoclave was purged with hydrogen, the contents were heated to 80°C with stirring. The hydrogen pressure was raised to 30 kg/cm² at the time the temperature was stable, thereby conducting a reaction for 3 hours white supplying hydrogen consumed in the course of the reaction. Then, 4.2 g of water and 2.5 g of activated alumina (specific surface ares: 320 cm²/g; pore volume 0.8 cm²/g; everage particle size: 15 µm; Neobead D powder, product of Mizusawa Industrial Chemicals, Inc.) were added to the reaction mixture followed by stirring at 80°C for 1 hour. Solids were then removed by filtration, and the resultant hydrogenation reaction mixture was poured into 3 liters of isopropyl alcohol to deposit a resin formed. The resin was collected by filtration and then dried for 48 hours at 100°C under 1 for or lower.
- 40 [0135] Fifty parts by weight of the thus-obtained polymer were mixed with 30 parts by weight of allyl glycidyl ether, 3.0 parts by weight of dicumyl peroxide and 120 parts by weight of t-butylbenzene to conduct a reaction at 150°C for 3 hours in an autoclave. The reaction mixture was then solidified and dried in the same manner as described above to obtain epoxy-modified Polymer (A). The result of the synthesis is shown in Table 1.

45 [Example 2]

[0136] Epoxy-modified Polymer (B) was obtained in the same manner as in Example 1 except that the amount of 1hexene was changed from 3.83 mmol to 5.75 mmol. The result of the synthesis is shown in Table 1.

50 [Example 3]

[0137] Maleic anhydride-modified Polymer (C) was obtained in the same manner as in Example 1 except that allyl olycidyl either was changed to maleic anhydride. The result of the synthesis is shown in Table 1.

55 [Example 4]

[0138] Maleic anhydride-modified Polymer (D) was obtained in the same manner as in Example 1 except that the amount of 1-hexene was changed from 3,83 mmol to 5.75 mmol, and allyl glycidyl ether was changed to maleic anhy-

dride. The result of the synthesis is shown in Table 1.

(Example 5)

5 (0139) Epoxy-modified Polymer (E) was obtained in the same manner as in Example 1 except that ETD was changed to tricyclo(4.3.0.1^{2.5})-3.7-decadiene (i.e., cicyclopentadiene; hereinafter referred to as "DCP"), and the amounts of allyl glycidyl ether and dicumyl peroxide were changed to from 30 parts by weight to 100 parts by weight, respectively. The result of the synthesis is shown in Table 1.

10 [Example 6]

[0140] Epoxy-modified Polymer (F) was obtained in the same manner as in Example 1 except that the amount of 1hexene was changed from 3.83 mmol to 5.75 mmol, ETD was changed to DCP, and the amounts of allyl glycidyl ether and dicumyl percoide were changed to from 30 parts by weight to 100 parts by weight and from 3.0 parts by weight 10 parts by weight, respectively. The result of the synthesis is shown in Table 1.

(Example 7)

[0141] Maleic anhydride-modified Polymer (G) was obtained in the same manner as in Example 1 except that ETD was changed to DCP, 30 parts by weight of allyl glycidyl ether were changed to 100 parts by weight of maleic anhydride, and the amount of dicumyl peroxide was changed from 3.0 parts by weight to 10 parts by weight. The result of the synthesis is shown in TaNth 1.

(Example 8)

[0142] Maleic anhydride-modified Polymer (H) was obtained in the same manner as in Example 1 except that the amount of 1-hexene was changed from 3.83 mmol to 5.75 mmol, ETD was changed to DCP, 30 parts by weight of allyl glycidyl ether were changed to 100 parts by weight of maleic anhydride, and the amount of dicumyl peroxide was changed from 3.0 parts by weight to 10 parts by weight. The result of the synthesis is shown in Table 1.

[Example 9]

[0143] Epoxy-modified Polymer (I) was obtained in the same manner as in Example 1 except that ETD was changed to 1,4-methano-1,4-4,9-a-tetrahydrofluorene (hereinafter referred to as "MTF"), and the amount of allyl gigicidyl either was changed to from 30 parts by weight to 50 parts by weight. The result of the synthesis is shown in Table 1.

[Example 10]

[0144] Epoxy-modified Polymer (J) was obtained in the same manner as in Example 1 except that the amount of 1to hexner was changed from 3.83 mmol to 5.75 mmol, ETD was changed to MTF, and the amount of allyl glycidyl ether was changed to from 30 parts by weight to 50 parts by weight. The result of the synthesis is shown in Table 1.

[Example 11]

5 [0145] Maleic anhydride-modified Polymer (K) was obtained in the same manner as in Example 1 except that ETD was changed to MTF, and 30 parts by weight of allyl glycidyl ether were changed to 50 parts by weight of maleic anhydride. The result of the synthesis is shown in Table 1.

[Example 12]

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[0146] Maleic anhydride-modified Polymer (L) was obtained in the same manner as in Example 1 except that the amount of 1-hexen was changed from 3.83 mmol to 5.75 mmol, ETD was changed to MTF, and 30 parts by weight of all

Table 1

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	r										
Bythogene- Hydrogena- Tg tion rate of tion rate of main chain mucleus		Ę.		Molecular weight after hydrog'n	wedght rog'n	Modify-	Modifit- cattlon rate	g.	Molecular weight after modif.	weight if.	8 2
_	_	S	_	Mn x 10'	N x 10,	drost	€	ઈ	An x 10	N x 10,	ì
2 99 - 138		138		1.85	3.16	Ppoxy	17	164	1.75	2.99	Ą
2 99 - 132		3		0.81	1.34	Possy	24	164	0.70	1.28	В
2 99		821		1.85	3.16	Maledo	16	159	1.91	3.22	υ
2 99 - 132		132		0.81	1.34	Maletc	ដ	191	96*0	1.69	Q
2 99 - 94		ž		1.66	2.81	Ppomy	19	777	1,51	2.66	ш
2 99 - 87	_	67		69.0	1.24	Eponcy	30	132	0.50	0.91	84
2 99 - 94		8		1.66	2.81	Maleto	19	611	1.80	3.03	٥
7 66 7		87		0.69	1.24	Maletc	28	126	96.0	1.51	Ξ
2 99 ⇒ 0 135		135		1.75	2.91	Pponry	17	191	1.32	2.18	ı
2 99 🖛 0 128		128		0.79	1.43	Poors	28	163	0.55	0.95	2
2 99 40 135		135		1.75	2.91	Maledo	19	154	1.68	2.79	×
2 99 年 0 128		128		0.79	1.43	Maledo	а	154	0.85	1.54	ı

(Comparative Example 1)

[0147] An unmodified hydrogenated product was synthesized in the same manner as in Example 1. The thusobtained product is referred to as Polymer (M). The result of the synthesis is shown in Table 2.

(Comparative Example 2)

[0148] Epoxy-modified Polymer (N) was obtained in the same manner as in Example 1 except that the amount of allyl glycidyl ether was changed from 30 parts by weight to 3 parts by weight. The result of the synthesis is shown in Table 2.

[Comparative Example 3]

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[0149] Maleic anhydride-modified Polymer (O) was obtained in the same manner as in Example 1 except that 30 parts by weight of allyl glycidyl ether were changed from to 3 parts by weight maleic anhydride. The result of the synthesis is shown in Table 2.

(Comparative Example 4)

[0150] An unmodified hydrogenated product was synthesized in the same manner as in Example 5. The thusobtained product is referred to as Polymer (P). The result of the synthesis is shown in Table 2.

[Comparative Example 5]

[0151] Epoxy-modified Polymer (C) was obtained in the same manner as in Example 5 except that the amounts of allyl glycidyl ether and dicumyl peroxide were changed from 100 parts by weight to 15 parts by welght and from 10 parts by weight to 1.0 part by weight, respectively. The result of the synthesis is shown in Table 2.

[Comparative Example 6]

30 [0152] Maleic anhydride-modified Polymer (R) was obtained in the same manner as in Example 5 except that the amounts of maleic anhydride and dicumyl perceide were changed from 10 parts by weight to 15 parts by weight and from 10 parts by weight to 1.0 part by weight, respectively. The result of the synthesis is shown in Table 2.

[Comparative Example 7]

[0153] An unmodified hydrogenated product was synthesized in the same manner as in Example 9. The thus-obtained product is referred to as Polymer (S). The result of the synthesis is shown in Table 2.

[Comparative Example 8]

[0154] Epoxy-modified Polymer (T) was obtained in the same manner as in Example 9 except that the amounts of allyl glycidyl ether and dicumyl percoide were changed from 50 parts by weight to 10 parts by weight and from 3.0 parts by weight to 1.0 part by weight 1.0

45 [Comparative Example 9]

[0155] Maleic anhydride-modified Polymer (U) was obtained in the same manner as in Example 11 except that the amounts of maleic anhydride and dicumyl peroxide were changed from 50 parts by weight to 10 parts by weight and from 3.0 parts by weight to 1.0 part by weight respectively. The result of the synthesis is, shown in Table 3.

[Comparative Example 10]

(0156) An unmodified hydrogenated product was synthesized in the same manner as in Example 1 except that the amount of 1-bevene was changed from 3.83 mmol to 2.30 mmol. The thus-obtained product is referred to as Polymer 50 (V). The result of the synthesis is shown in Table 2.

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weight if.	M x 10,		3.10	3.15		2.77	2.98		2.71	2.85	٠
Molecular weight after modif.	M x 10*		1.80	1.81		1.58	1.70	,	1.60	1.70	
2	ઈ	•	150	151	•	115	109	•	145	143	٠
Modifia- cetton	2		5	۰		,	,		2	-	
-fully-	di nos		Epong	Maledo		àmoda	Maledo		Boary	Maleto	
weight zog'n	M x 10	3.16	3.16	3.16	2.81	2.81	2.18	2.91	2.91	2.91	5.78
Molecular weight after hydrog'n	Mn x 10*	1.85	1.85	1.85	1.66	1.66	1.66	1.73	1.75	1.75	2.85
2	9	138	138	82	2	36	2	E	52	SI	140
Hydrogena- tion rate of	€							4	† 0	40	
Hydrogena- tion rate of main chain	(8)	2 39	86 ~	86 ~	5 29	2 99	7 39	5 29	2.99	5 %	7 39
Polymer- ization	method	Ring- opening	Ring- opening	Ring- opening	Rtng- opening	Ring- opening	Ring- opening	Ring- opening	Rtng- opening	Ring- opening	Ring- opening
Polymer comp'n	(F. 8)	(100)	(100)	(100)	(100)	(100)	(100)	(100)	(00T)	(100)	(00T) CESS
		i K	Comp.	Comp.	Zengo.	Comp.	Comp.	Comp.	Combo Sk. 8	S Si	Cento. 18. 10

(Examples 13 to 24)

[0157] The individual modified polymers obtained in Examples 1 to 12 and various kinds of components were blended so as to give their corresponding compositions shown in Table 3, and the thus-obtained compositions were separately dissolved in toluene to give a solids concentration of 50 to 60 wt.%, thereby preparing respective varnishes. After these solutions were left at rest for 30 minutes, uniformity of the solutions was visually evaluated to rank them in accordance with the following standard:

Uniformity of solution:

[0158]

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- O: The solution was completely uniform; and
- X: The solution underwent phase separation.

[0159] An E glass cloth 10 cm wide, 10 cm long and about 0.5 mm thick was dipped for 10 seconds in each of these solutions, slowly pulled up and then left to stand for 1 minute. Only solids in the resin-impregnated glass cloth through obtained were dissolved again in toluene, and the resultant solution was poured into a large amount of isophy acetate to solidify a modified polymer portion. The solidified polymer was collected by filtration. On the other hand, the filtrate was poured into a large amount of methanol to collect a llame retardant portion in the same manner as described above.

[0160]. These portions were separately dried for 48 hours at 70°C under 1 for to measure their weights. The uniformity of impregnation was evaluated on the basis of a difference between a weight ratio of the two components at this time and a weight ratio of the two components in a state of the varnish to rank it in the following standard:

Uniformity of impregnation:

[0161]

- The difference in weight ratio was lower than 2%:
- O: The difference in weight ratio was not lower than 2%, but lower than 5%;
- Δ: The difference in weight ratio was not lower than 5%, but lower than 10%; and
- X: The difference in weight ratio was not lower than 10%.
- 35 [0162] Further, an E glass cloth was dipped in and impregnated with each of the above solutions and then dried in an air oven to prepare a curable composite material (prepreg). The weight of the base material in the prepreg was controlled to 40% based on the weight of the prepreg. As needed, plural sheets of the thus-produced prepreg were stacked on one another so as to give a thickness of 0.8 mm after molding, and a copper foil 35 µm thick was placed on both sides thereof. The thus-obtained laminate was molded and cured by a hot pressing machine to obtain a resin laminate.
 40 [0163] Various physical properties of the resin laminates obtained in such a manner were measured. As a result, all
- (40 [0163] Various physical properties of the resin laminates obtained in such a manner were measured. As a result, all the resin laminates exhibited good dielectric constant and copper foil peeling strength and had flame retardancy of V-0.

Table 3

						7							
Copper foll	strength (kg/am²)	2.0	2.3	1.9	2.1	2.0	2.6	2.1	2.5	2.1	2.3	1.8	2.2
Dielec. const.	u	.3.05	3.10	3.00	3.05	3.00	3.15	3.00	3.10	3.05	3.05	3.00	3.05
Uniformity	Impregnation	0	0	0	0	0	0	0	0	0	0	٥	0
Pat	Solution	0	0	0	0	0	0	0	0	0	0	0	0
Solids conc'n	€	20	09	05	09	90	09	ន	8	ន	8	ß	9
Hardener	(part)	Imidazole (1)	Imidezole (1)	Imidazole (1)	Imidazole (1)								
Flame retardant	(part)	p (40)	b (40)	p (40)	p (40)	(0)) q	p (40)	p (40)	b (40)	b (40)	p (40)	p (40)	b (40)
Cross- Linking	(part)	TAIC (S)	TATC (S)	TAIC (5)	TAIC (S)	TAIC (5)	TPAIC (5)	TMIC (5)	TAIC (5)				
Percedde	(part)	a (1)	a (1)	a (1)	a (1)	8 (1)	a (1)	a (1)	a (1)	(T) 8	a (1)	g (1)	£ (5)
Polymer	(part)	A (60)	B (60)	c (60)	(09) Q	E (60)	F (60)	(09) g	(09) н	I (60)	(09) 5	K (60)	r (60)
		EX. 13	Ex. 14	Ex. 15	DX. 16	Ex. 17	Ex. 18	EK. 19	8. B	z z	2 23	23	ğ. 22

(Note)

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Peroxide: a = 2,5-Dimethyl-2,5-di(t-butyl peroxy)hexyne-3;

Crosslinking aid: TAIC - Triallyl isocyanurate:

Plame retardant: b = Brominated bisphenol A type epoxy

resin (AER 8010, product of Asahi-CIBA

Limited: Br content: 5 wt.%):

Hardener: Imidazole = 2-Ethyl-4-methylimidazole.

[0164] It is understood from Table 3 that even when the modified polymers (Examples 13 to 24) according to the present invention are prepared into solutions at a solids concentration of 50 to 60 wt%, the compounding additives such as the crosslinking agent, crosslinking aid, flame retardant and hardener can be uniformly dispersed therein, and the resultant moldings are excellent in both dielectric constant and cooper foil peeling strength.

[Comparative Examples 11 to 20]

[0165] Respective experiments were conducted in the same manner as in Examples 13 to 24 except that the modified or unmodified polymers obtained in Comparative Examples 1 to 10 were used in place of the modified polymers obtained in Examples 1 to 12. The results are shown in Table 4.

					Table 4					
	Polymer	Percedde	Cross- 11nking atd	Flame retardant	Hardener	Solids conc'n	Und	Uniformity	Dielec. const.	Copper foil reeling
	(part)	(part)	(part)	(part)	(part)	8	Solution	Impregnation	u	strength (kg/am²)
Comp. Ex. 11	(09) м	a (1)	TAIC (S)	b (40)	Imidazole (1)	8	0	© .	2.90	9.0
Остр. Вх. 12	N (60)	a (1)	TOLIC (5)	b (40)	Imidazole (1)	S	0	0	2.95	1.0
Ocmp. Ex. 13	(09) 0	a (1)	TALC (S)	b (40)	Imidazole (1)	25	0	0	2.95	1.0
Comp. Ex. 14	P (60)	a (1)	'ENIC (5)	b (40)	Imidezole (1)	20	0	0	2.90	9.0
Comp. Ex. 15	(09) 0	a (1)	TAIC (5)	b (40)	Imidazole (1)	50	0		2.95	1.0
Comp. 15. 16	R (60)	a (1)	TAIC (5)	b (40)	Inidazole (1)	80	0	0	2.95	1.0
Comp. 17.	(09) S	a (1)	'muc (s)	b (40)	Imidazole (1)	50	0	0	2.90	9.0
Comp.	T (60)	a (1)	TAIC (S)	b (40)	Imidazole (1)	20	0	0	2.95	1.0
Comp. 19. 19	(09) n	a (1)	TAIC (5)	b (40)	Inddazole (1)	25	0	0	2.95	1.0
EX. 20	(09) A	a (1)	TAIC (S)	b (40)	Imidazole (1)	20	×	·×	2.90	9.0

[0166] It is understood from the results shown in Table 4 that the unmodified polymers and the modified polymer low in modification rate exhibit insufficient copper foil peeling strength.

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(Example 25)

[0167] Epoxy-modified Polymer (a) was obtained in the same manner as in Example 1 except that the amount of 1hexene was changed from 3.83 mmol to 1.86 mmol. The result of the synthesis is shown in Table 5.

(Example 26)

[0168] Maleic anhydride-modified Polymer (b) was obtained in the same manner as in Example 25 except that 30 parts by weight of allyl glycidyl ether were changed to 30 parts by weight of maleic anhydride. The result of the synthe-0 sis is shown in Table 5.

[Example 27]

(0169) Epoxy-modified Polymer (c) was obtained in the same manner as in Example 25 except that ETD was changed to DCP, and the amounts of allyl glycidyl ether and dicumyl peroide were changed from 30 parts by weight to 10 parts by weight. The result of the synthesis is shown in Table

[Example 28]

[0170] Maleic anhydride-modified Polymer (d) was obtained in the same manner as in Example 27 except that allyl glycidyl ether was changed to maleic anhydride. The result of the synthesis is shown in Table 5.

[Example 29]

[0171] Epoxy-modified Polymer (e) was obtained in the same manner as in Example 25 except that ETD was changed to MTF, and the amount of allyl glycically either was changed from 30 parts by weight to 50 parts by weight. The result of the synthesis is shown in Table 5.

30 [Example 30]

[0172] Maleic anhydride-modified Polymer (f) was obtained in the same manner as in Example 29 except that allyl glycidyl ether was changed to maleic anhydride. The result of the synthesis is shown in Table 5.

35 [Comparative Example 21]

[0173] An unmodified hydrogenated product was synthesized in the same manner as in Example 25. The thusobtained product is referred to as Polymer (g). The result of the synthesis is shown in Table 5.

40 [Comparative Example 22]

[0174] Epoxy-modified Polymer (h) was obtained in the same manner as in Example 25 except that the amount of allyl glycidyl ether was changed from 30 parts by weight to 3.0 parts by weight. The result of the synthesis is shown in Table 5.

[Comparative Example 23]

[0175] Maleic anhydride-modified (i) was obtained in the same manner as in Example 26 except that the amount of maleic anhydride was changed from 30 parts by weight to 3.0 parts by weight. The result of the synthesis is shown in Table 5.

[Comparative Example 24]

[0176] An unmodified hydrogenated product was synthesized in the same manner as in Example 27. The thusto obtained product is referred to as Polymer (j). The result of the synthesis is shown in Table 5.

[Comparative Example 25]

[0177] Epoxy-modified Polymer (k) was obtained in the same manner as in Example 27 except that the amount of allyl glycidyl ether was changed from 100 parts by weight to 15 parts by weight. The result of the synthesis is shown in Table

(Comparative Example 26)

[0178] Maleic anhydride-modified (1) was obtained in the same manner as in Example 28 except that the amount of 10 maleic anhydride was changed from 100 parts by weight to 15 parts by weight. The result of the synthesis is shown in Table 5.

[Comparative Example 27]

15 [0179] An unmodified hydrogenated product was synthesized in the same manner as in Example 29. The thus-obtained product is referred to as Polymer (m). The result of the synthesis is shown in Table 5.

[Comparative Example 28]

20 [0180] Epoxy-modified Polymer (n) was obtained in the same manner as in Example 29 except that the amount of ally glycidyl ether was changed from 50 parts by weight to 10 parts by weight. The result of the synthesis is shown in Table 5.

(Comparative Example 29)

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[0181] Maleic anhydride-modified (o) was obtained in the same manner as in Example 30 except that the amount of maleic anhydride was changed from 50 parts by weight to 10 parts by weight. The result of the synthesis is shown in Table 5.

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J	C	3	
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	Polymer comp'n	Polymer- ization	Hydrogena- tion rate of	Hydrogena- tion rate of	2	Molecular weight after hydrog'n	wedght rog'n	Modify-	Modifi- cation	P	Molecular weight after modif.	weight if.	8
	(wt.8)	method	(£)	(\$)	ઈ	M x 104	N × 10*	drand	(£)	ဥ	Mn x 104	Mr x 10	ģ
Bx. 25	(100)	Ring- opening	7 39		140	2.45	4.54	Bponty	17	25	2.40	4.41	•
Ex. 26	(100)	Ring- opening	7 39		140	2.45	4.54	Maledo	56	191	2.60	4.68	م
Ex. 27	60T)	Ring- opening	7 39		8	2.11	4.45	Phoney	15	122	2.06	4.31	0
Ex. 28	(100)	Rung- opening	7 39		æ	2.11	4.45	Maletc	16	119	2.24	4.60	₽
Ex. 29	MIT (100)	Ring- opening	2 99	40	135	2.20	4.43	Poory	21	191	2.08	4.30	
EX. 30	(100)	Ring- opening	7 89	10	135	2.20	4.43	Maledo	19	251	2.28	4.61	a.
Comp. Ex. 21	(100)	Rdng- opening	7 99		140	2.45	4.54			Ŀ			Б
Comp.	ETD (100)	Ring- opening	7 99		140	2.45	4.54	Epony	s	151	2.40	4.46	д
C. 23	,	Ring- opening	5 66 ₹		140	2.45	4.54	Maleic	ın	144	2.51	4.57	4
Comp. Ex. 24	80E)	Ring- opening	7 99		56	2.11	4.45	•	•	•	٠	•	ŗ
, S	<u> </u>	Ring- opening	. 38	-	8	2.11	4.45	Bpony	9	115	2.08	4.37	×
% 15.00 15.	(100 E	Ring- opening	7 99		56	2.11	4.45	Maleto	7	109	2.15	4.50	-
S. 27		Ring- opening	2 99	40	327	2.20	4.43	•	•	٠		•	6
. E. E.	MTF (100)	Rtng- opening	5 99	40	135	2.20	4.43	Pposty	•	145	2.16	4.35	c
is de	(100)	Ring- opening	7 99	40	551	2.20	4.43	Maleto	2	142	2.21	4.47	•

[Examples 31 to 36]

[0182] Thirty parts by weight of each of the modified polymers obtained in Examples 25 to 30 and 1.2 parts by weight of bisazidobenzal(4-methyl)cyclohexanone were dissolved in 100 parts by weight of xylene. Each composition was provided as a uniform solution without forming any precipitate.

5 vided as a uniform source without forming any precipitate.
(9183) This uniform solution was then coated on a silicion water, in which an aluminum wiring had been formed on an SiO₂ film 4000 Å thick, by a spin coating process, and the thus-coated solution was prebaked at 90°C for 60 seconds, thereby forming a coating film 3.3 µm thick on the aluminum wiring. Each sample thus obtained was cured at 250°C for 3 hours under nitrogen, thereby forming an overcoat 3 µm thick to evaluate it as to dielectric constant, adhesion property, soldering heat resistance and durability (heat resistance and moisture resistance). The results are shown in Table

[Comparative Examples 30 to 38]

15 [0184] Respective experiments were conducted in the same manner as in Examples 25 to 30 except that the modified or unmodified polymers obtained in Comparative Examples 21 to 29 were used in place of the modified polymers obtained in Examples 25 to 30. The results are shown in Table 6.

Table 6

	Soldering heat resist- ance	Adhesion property to alumin, wiring- tormed silicon water	Change in metal layer after durability test	Dielec. loss tangent	Dialec. const. (1 MHz)	Code No
Ex. 31	Good	100/100	Not changed	0.0009	2,3	а
Ex. 32	Good	100/100	Not changed	0.0009	2.3	ь
Ex. 33	Good	100/100	Not changed	0.0007	2.2	C
Ex. 34	Good	100/100	Not changed	0.0007	2.2	d
Ex. 35	Good	100/100	Not changed	0.0009	2.3	е
Ex. 36	Good	100/100	Not changed	0.0009	2.3	1
Comp. Ex. 30	Poor	5/100	Corroded and tarnished	0.0007	2.2	9
Comp. Ex. 31	Partially deformed	20/100	Not changed	0.0009	2.3	h
Comp. Ex. 32	Partially deformed	20/100	Not changed	0.0009	2.3	'
Comp. Ex. 33	Poor	3/100	Corroded and tarnished	0.0007	2.2	ì
Comp. Ex. 34	Partially deformed	20/100	Not changed	0.0007	2.2	k
Comp. Ex. 35	Partially deformed	20/100	Not changed	0.0007	2.2	
Comp. Ex. 36	Poor	5/100	Corroded and tarnished	0.0007	2.2	m
Comp. Ex. 37	Partially deformed	20/100	Not changed	0.0009	2.3	n
Comp. Ex. 38	Partially deformed	20/100	Not changed	0.0009	2.3	•

[0185] It is understood from the results shown in Table 6 that when the modified polymers according to the present invention are used, overcoats (or interlayer insulating films) excellent in soldering heat resistance, adhesion property, druzblifty, electrical properties and the like can be obtained.

(INDLISTRIAL APPLICABILITY)

[0186] According to the present invention, there are provided modified thermoplastic non-bornene polymers excellent in electrical properties such as dielectric constant and dielectric loss tangent and also in adhesion property to other materials such as metals and silicon wafers, a production process thereot, crosslinking polymer compositions comprising such a modified thermoplastic non-bornene polymer and a crosslinking agent, moldings thereof, and sheets, prepress, laminates and the like using such a composition. The modified thermoplastic non-bornene polymers and compositions comprising such a polymer according to the present invention can be applied to a wide variety of fields such as circuits boards; interlayer insulating films, semiconductor devices and electronic parts in precision apparatus such as electronic computers and communication machines.

Claims

- 1. A modified thermoplastic norbornene polymer obtained by graft-modifying a thermoplastic norbornene polymer selected from a ring-opening polymer of a norbornene monomer or a hydrogenated product thereof with at least one unsaturated compound selected from the group consisting of unsaturated epoxy compounds and unsaturated carboxylic compounds, wherein the modified polymer has a rate of graft modification of at least 10 mol% and a number average molecular weight (Mn) of SQ0 to SQ0 000.
- The modified thermoplastic norbornene polymer according to Claim 1, wherein the thermoplastic norbornene polymer is a polymer having repeating units represented by the formula (A):



wherein R^1 to R^9 are independently a hydrogen atom, hydrocarbon group, halogen atom, alkoxy group, ester group, cyano group, amide group, limide group, silyl group or hydrocarbon group substituted by a polar group (i.e., a halogen atom, alkoxy group, ester group, cyang group, amide group, iride group, with the proviso that at least two of R^5 to R^9 may be bonded to each other to form a monocycle or polycycle, the monocycle or polycycle may have carbon-carbon double bond(s) or be in the form of an aromatic ring, and R^9 and R^9 , or R^7 and R^9 may form an allylidene group, and $\frac{1}{2} \cdots \frac{1}{2}$ means either a single bond or a double bond.

- The modified thermoplastic norbornene polymer according to Claim 1 or 2, wherein the rate of graft modification is
 10 to 100 mol%.
 - The modified thermoplastic norbornene polymer according to Claim 1 or 2, wherein the rate of graft modification is 15 to 50 mg/%.
- The modified thermoplastic norbornene polymer according to any one of Claims 1 and 4, wherein the number average molecular weight (Mn) falls within a range of 500 to 20,000.
 - The modified thermoplastic norbornene polymer according to any one of Claims 1 and 4, wherein the number average molecular weight (Mn) falls within a range of from higher than 20,000 to not higher than 500,000.
 - 7. A process for producing a modified thermoplastic norbormene polymer having a rate of graft modification of at least 10 mot/s and a number average molecular weight (Mn) of 500 to 500,000, the process comprising reacting attenmoplastic norbornene polymer selected from a ring-opening polymer of a norbornene monomer or a hydrogenated

product thereof and having a number average molecular weight (Mn) of 500 to 500,000 with at least one unsaturated compound selected from the group consisting of unsaturated epoxy compounds and unsaturated carboxylic compounds in the presence of an organic periodic.

5 8. A crosslinking polymer composition comprising a modified thermoplastic norbornene polymer obtained by graft-modifying a thermoplastic norbornene polymer selected from a ring-opening polymer of a norbornene monomer or a hydrogenated product thered with at least one unsaturated compound selected from the group consisting of unsaturated epoxy compounds and unsaturated carboxylic compounds, and having a rate of graft modification of at least 10 mol% and a number average molecular weight (Mn) of 500 to 500,000, and a crosslinking agent.

10

- The crosslinking polymer composition according to Claim 8, wherein the crosslinking agent is selected from ① an
 organic peroxide. ② a crosslinking agent capable of exhibiting its effect by heat or ③ a crosslinking agent capable
 of exhibiting its effect by light.
- 15 10. The crosslinking polymer composition according to Claim 8 or 9, wherein the crosslinking agent is contained in a proportion of 0.001 to 30 parts by weight per 100 parts by weight of the modified thermoplastic norbornene polymer.
- 11. The crosslinking polymer composition according to, any one of claims 8 to 10, which further comprises a crosslinking aid.
 - The crosslinking polymer composition according to any one of claims 8 to 11, which further comprises a flame retardant.
- 25 13. A molding obtained by molding the crosslinking polymer composition according to any one of Claims 8 to 12.
 - 14. A laminate having a structure that a layer formed of the crosslinking polymer composition according to any one of Claims 8 to 12 is laminated on a metal layer.
- 30 15. A prepreg comprising a reinforcing base material impregnated with the crosslinking polymer composition according to any one of Claims 8 to 12.